

# Transient Simulations: Weighting Potentials through Technology Computer-Aided Design

Manuel Alejandro Del Rio Viera

Allpix Squared 4<sup>th</sup> Workshop

May 23<sup>rd</sup> 2023

HELMHOLTZ UNIVERSITÄT BONN



DESY.



# The Tangerine Project



**Goal:** Develop the next generation of monolithic silicon pixel detectors using a 65 nm CMOS imaging process

## Requirements

- Spatial Resolution ~ 3  $\mu\text{m}$
- Time Resolution ~ 1 -10 ns
- Low material budget ~ 50  $\mu\text{m}$  silicon

**Application:**  $e^+e^-$  Colliders  

Reference detector at DESY-II test beam

- Funded by Helmholtz Innovation Pool and DESY

Part of the **Work Package 1 (WP1):** Monolithic pixel detectors in novel CMOS imaging technology

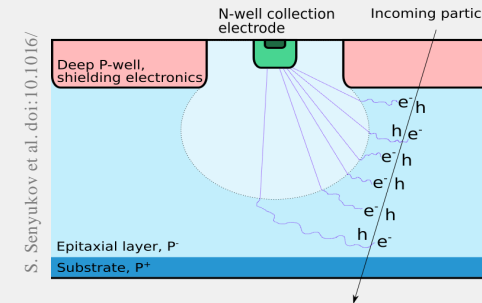
**HELMHOLTZ**

# TowArds Next GEneRation SiLicoN DEtectors



## Monolithic Active Pixel Sensors (MAPS)

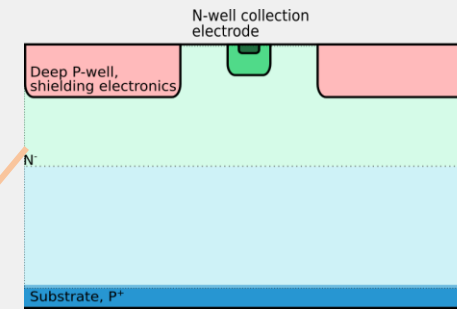
### Standard



Small Collection Electrode

### N-Blanket

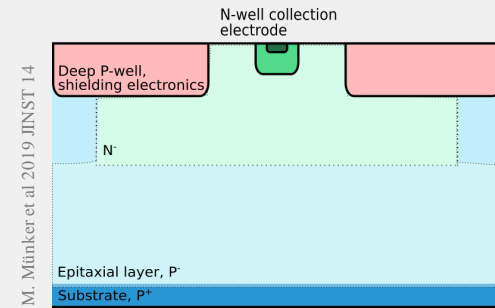
Continuous N-type Implant



Increase the depleted region

### N-Gap

Gap in Continuous N-type Implant



Speed up charge collection

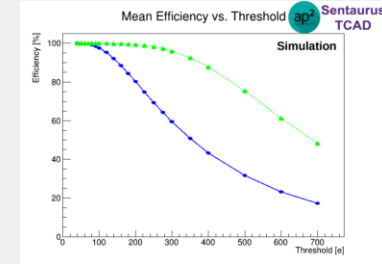
# Simulation's Workflow



## Why do we need Transient Simulations?



Compare data with simulations

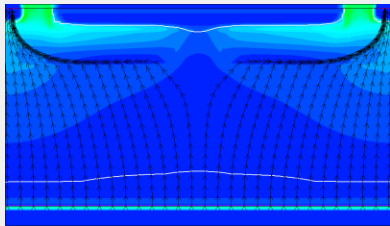


See Adriana's presentation On Simulations and Test Beam Characterization

Device Simulations (TCAD)

Monte Carlo Simulations

SYNOPSYS®



Allow to optimize the layouts that characterize a sensor

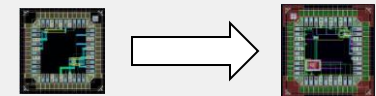
- Electric Fields
- Process Simulations
- Capacitance
- Weighting Potentials

Allow for greater statistics and to analyze detector performance

- Efficiency
- Cluster Size and Resolution
- Pulses

### Motivation of Transient Simulations

- Produce accurate pulses in more realistic simulations
- Predict sensor and precise FE response
- Optimize our sensors.

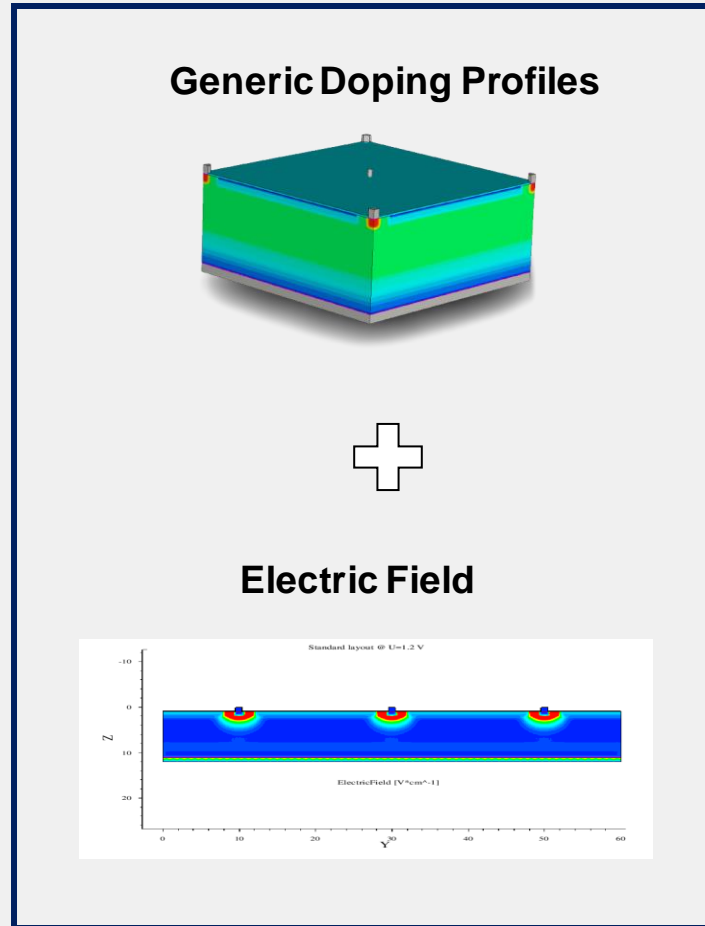


# Allpix Squared + TCAD

## Transient Simulations - Full Detector Response

The **static** Electric Field, Doping Concentration and Electrostatic Potential Profiles are converted and imported into **Allpix Squared (APSQ)**:

→ **Combining the best of both** : **High statistics** and **accurate field modeling**

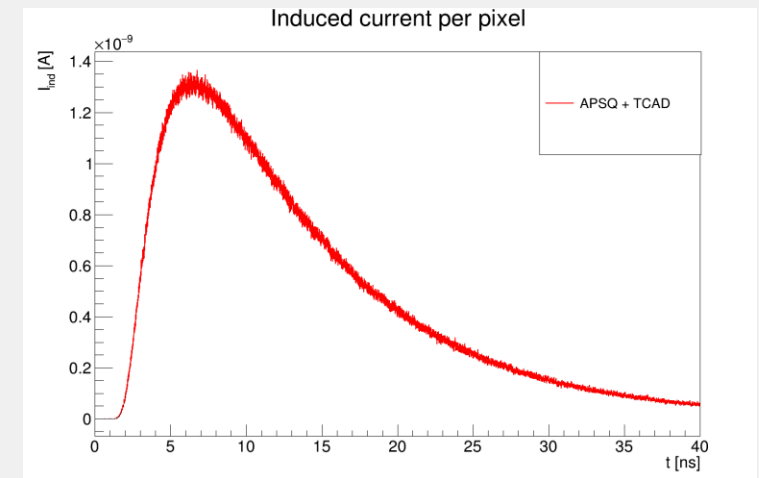
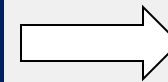
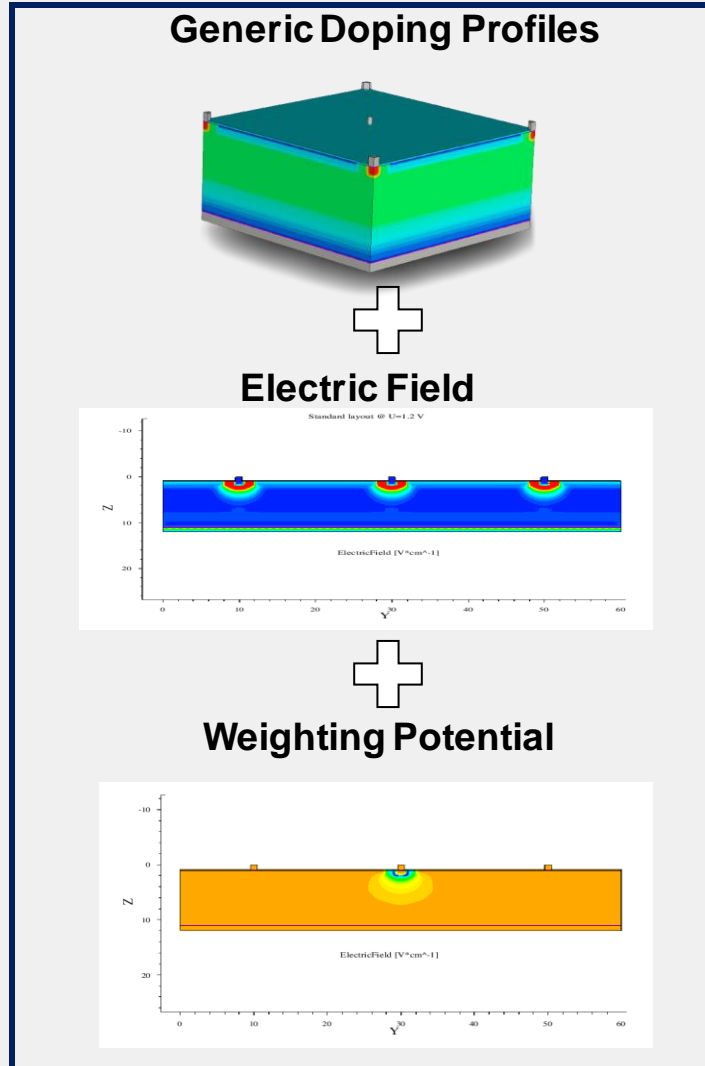
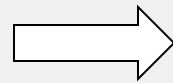


# Allpix Squared + TCAD

## Transient Simulations - Full Detector Response

The **static** Electric Field, Doping Concentration and Electrostatic Potential Profiles are converted and imported into **Allpix Squared (APSQ)**:

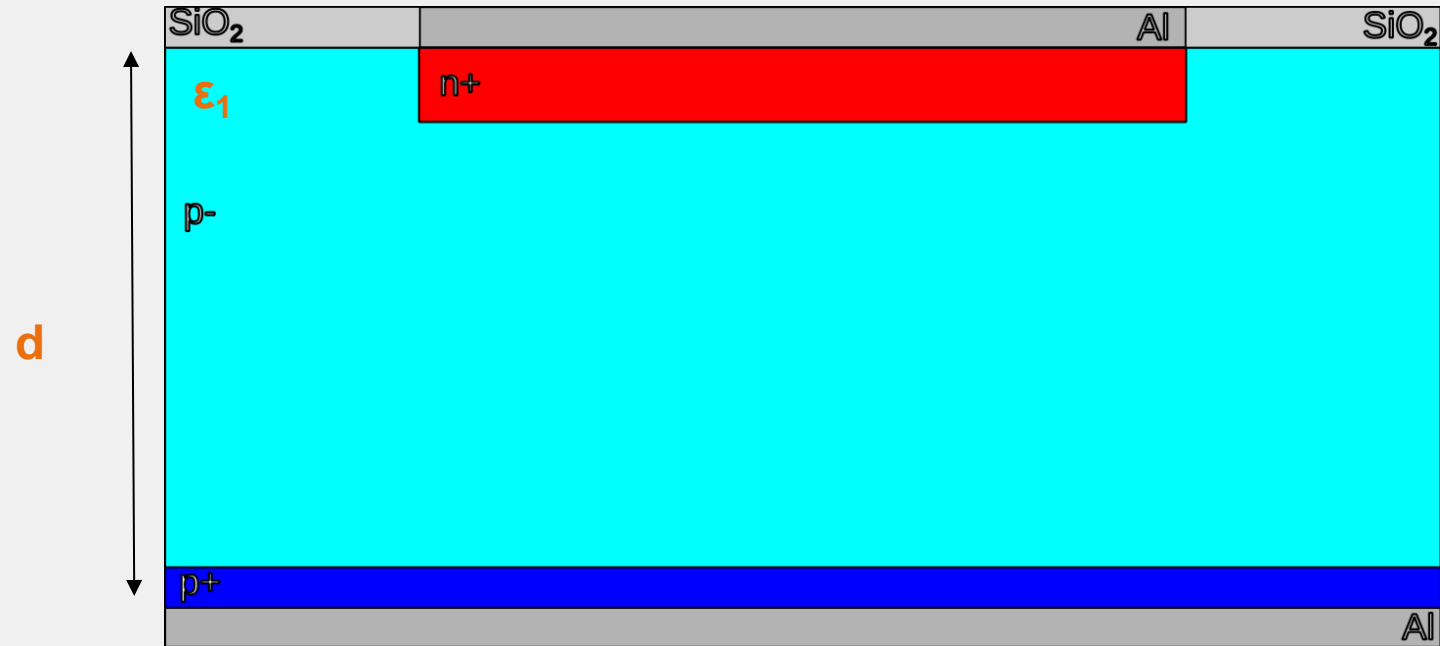
→ **Combining the best of both**: **High statistics** and **accurate field modeling**



**Produce accurate pulses, and thus predict sensor and FE behavior!**

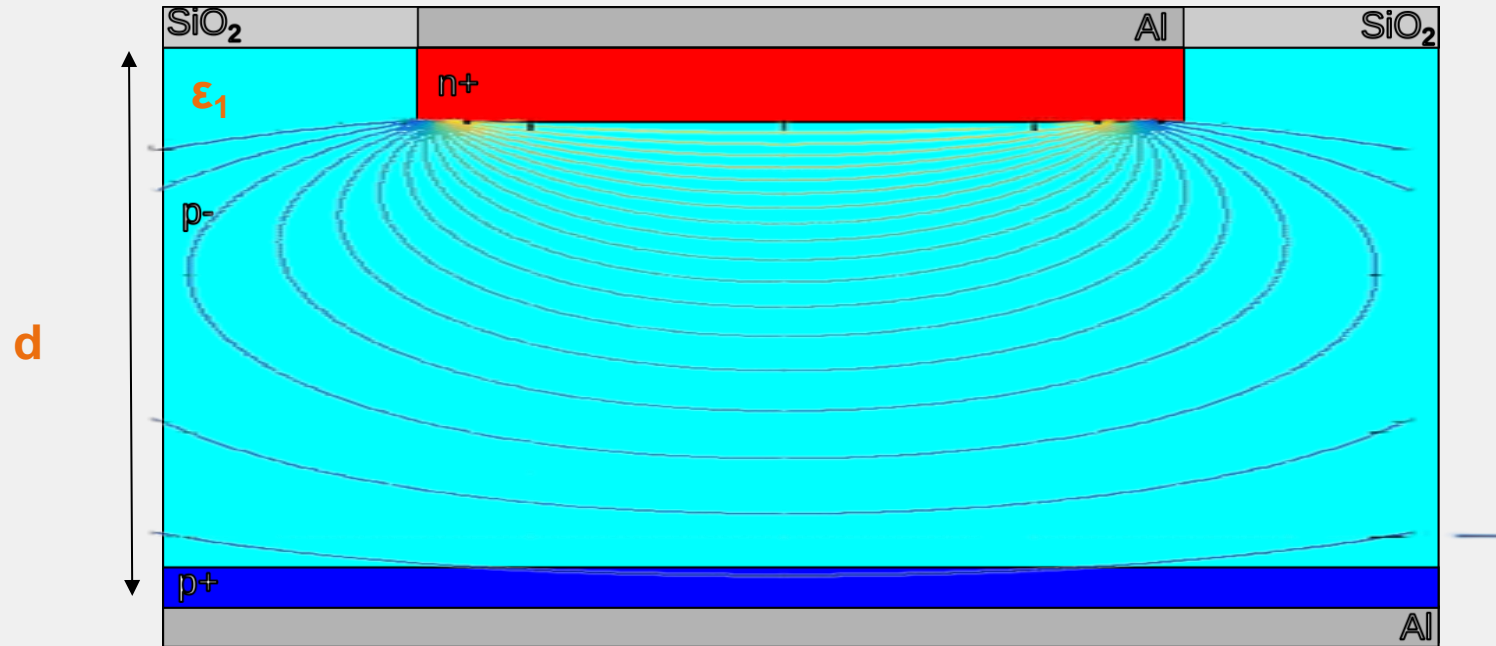
# Shockley-Ramo's Theorem

## Signal Formation on Silicon Sensors



# Shockley-Ramo's Theorem

## Signal Formation on Silicon Sensors

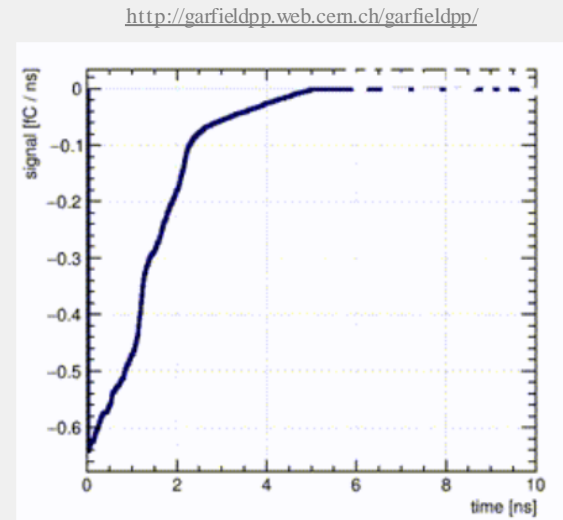
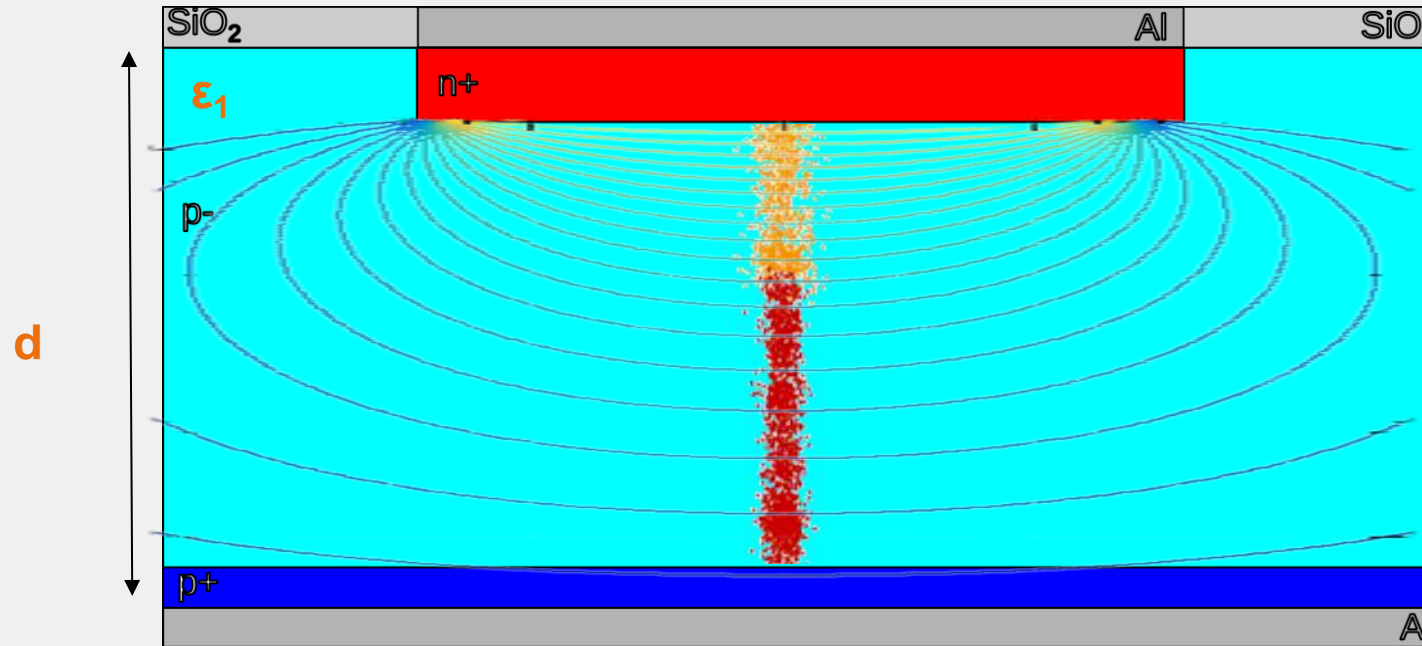


$$\varphi_w = \frac{\varphi_0}{U}; \vec{E}_w = -\vec{\nabla}\varphi_w$$

# Shockley-Ramo's Theorem

## Signal Formation on Silicon Sensors

$$I_{ind} = q\vec{E} \cdot \vec{v}$$
$$Q_{ind} = q(\varphi_w(\vec{r}_{t_0}) - \varphi_w(\vec{r}_t))$$



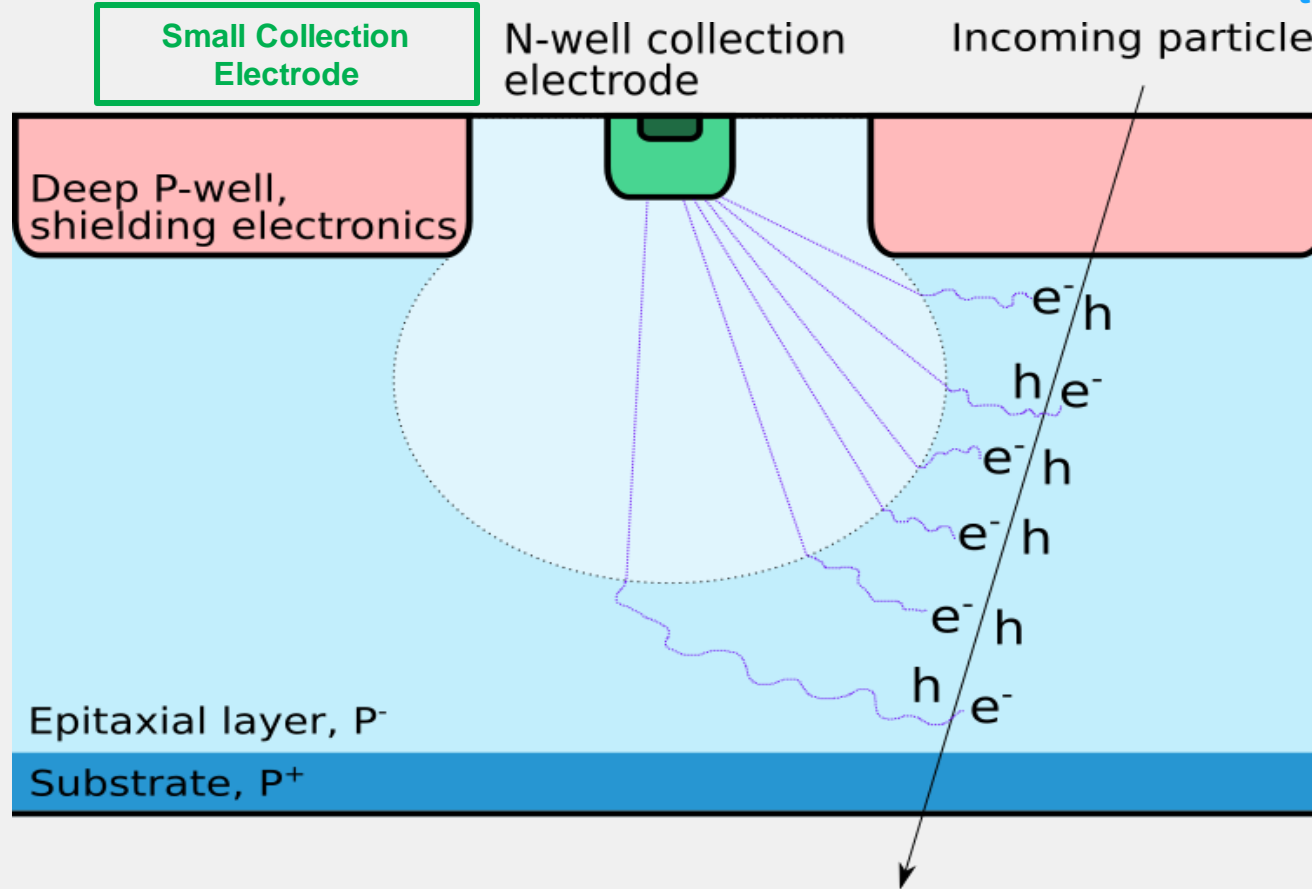
$$\varphi_w = \frac{\varphi_0}{U}; \vec{E}_w = -\vec{\nabla}\varphi_w$$



# Monolithic Active Pixel Sensors (MAPS)

Thanks to Anastasiia Velyka and Adriana Simancas for providing all the fields!

## Standard



S. Senyukov et al. doi:10.1016/

# [WeightingPotentialReader]

Adds a weighting potential (Ramo potential) to the detector from one of the supported sources. This module support **two types of weighting potentials**.

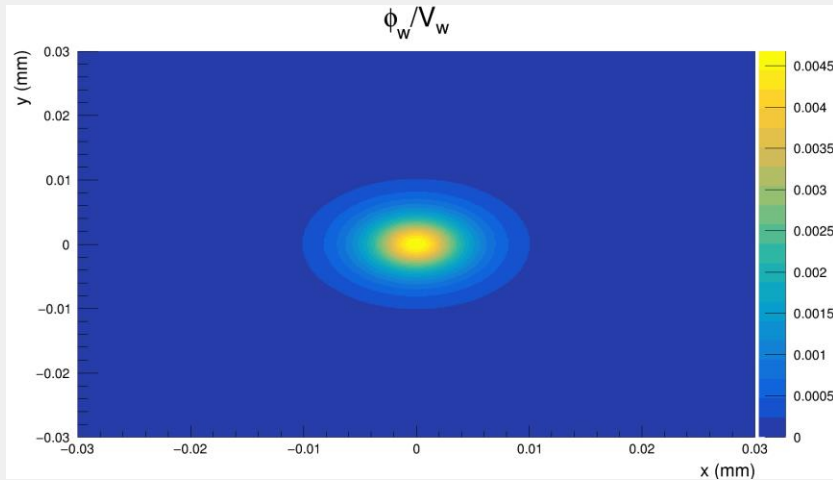


```
[WeightingPotentialReader]
model = "pad"
output_plots=true
field_scale= 3 3 #Odd number
```

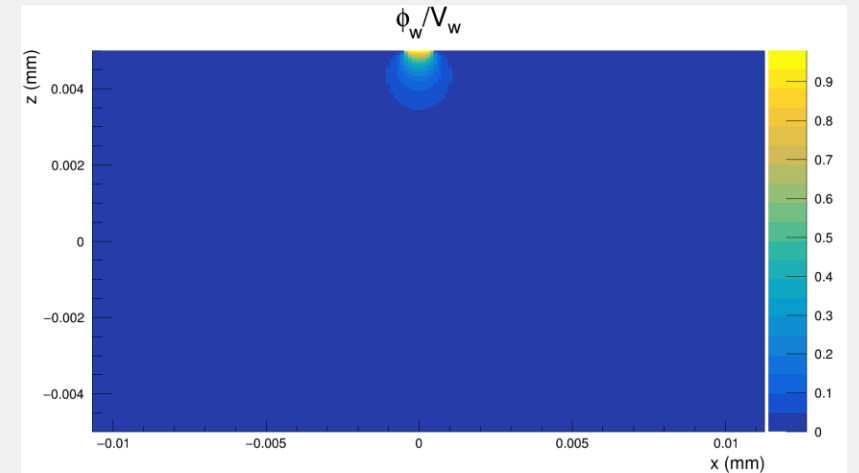
**Simulation  
time consuming!**

## Models

"Pad"



Upper view of WP (of a 20x20 $\mu\text{m}^2$  pitch pixel and 10 $\mu\text{m}$  thickness)



Transversal cut of WP (of a 20x20 $\mu\text{m}^2$  pitch pixel and 10 $\mu\text{m}$  thickness)

# [WeightingPotentialReader]

Adds a weighting potential (Ramo potential) to the detector from one of the supported sources. This module support **two types of weighting potentials**.

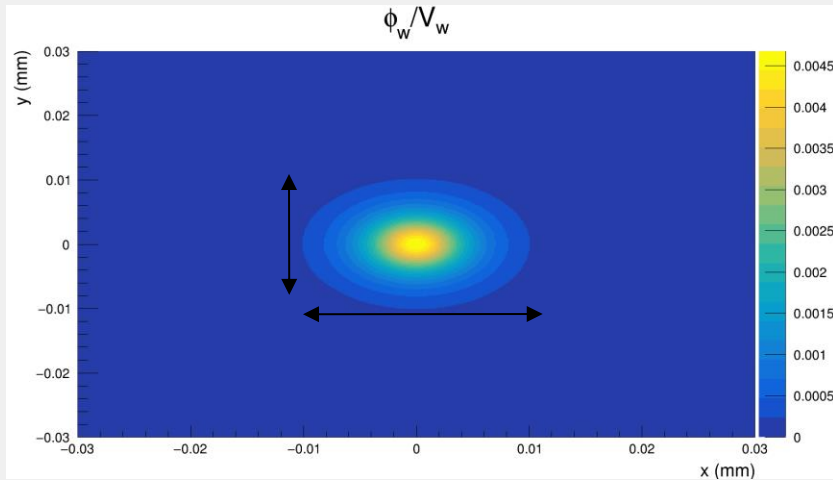


```
[WeightingPotentialReader]  
model = "pad"  
output_plots=true  
field_scale= 3 3 #Odd number
```

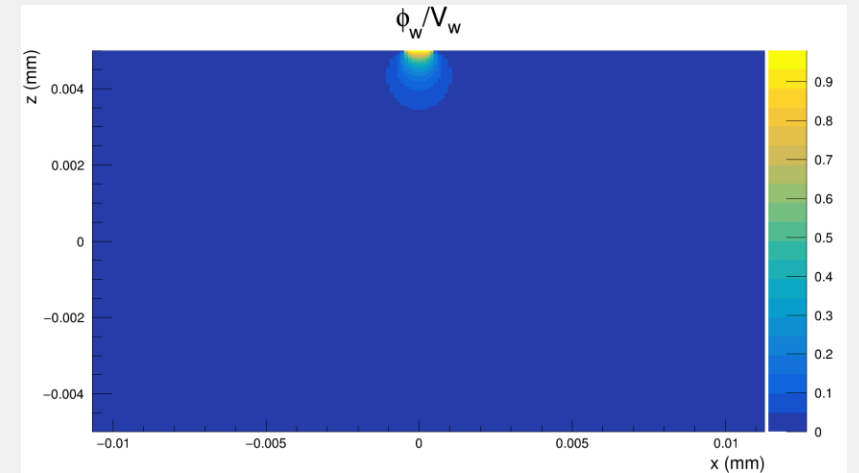
**Simulation  
time consuming!**

## Models

"Pad"



Upper view of WP (of a 20x20 $\mu\text{m}^2$  pitch pixel and 10 $\mu\text{m}$  thickness)



Transversal cut of WP (of a 20x20 $\mu\text{m}^2$  pitch pixel and 10 $\mu\text{m}$  thickness)

# [WeightingPotentialReader]

Adds a weighting potential (Ramo potential) to the detector from one of the supported sources. This module support **two types of weighting potentials**.

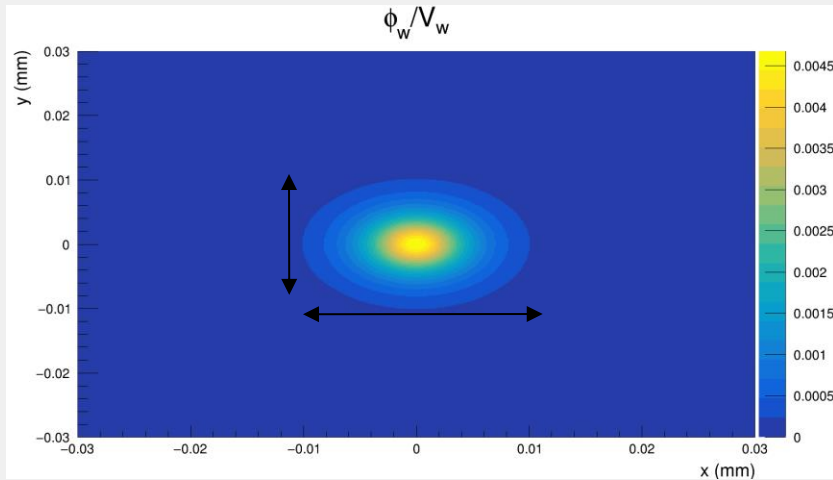


```
[WeightingPotentialReader]  
model = "pad"  
output_plots=true  
field_scale= 3 3 #Odd number
```

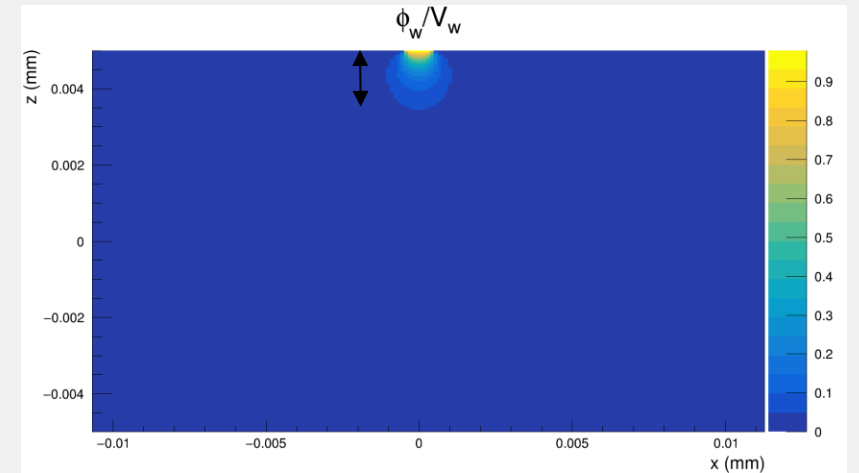
**Simulation  
time consuming!**

## Models

"Pad"



Upper view of WP (of a 20x20 $\mu\text{m}^2$  pitch pixel and 10 $\mu\text{m}$  thickness)



Transversal cut of WP (of a 20x20 $\mu\text{m}^2$  pitch pixel and 10 $\mu\text{m}$  thickness)

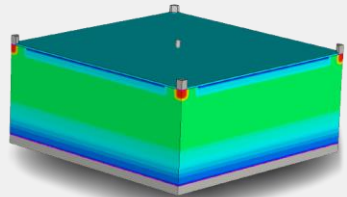
# [WeightingPotentialReader]

Adds a weighting potential (Ramo potential) to the detector from one of the supported sources. This module support **two types of weighting potentials**.



```
[WeightingPotentialReader]  
model = "mesh"  
file_name = "WP.apf" or "WP.init"  
field_scale= 3 3 #Odd number
```

## SYNOPSYS®



.grd & .dat



mesh\_converter

### Models

"Mesh"

generate\_potential



# generate\_potential Tool



This tool allows to generate simple Weighting Potential based on a **sensor model file**

```
generate_potential --model Sensor.conf --binning 300,300,100 --matrix 3,3 --output WP --init
```

# generate\_potential Tool



This tool allows to generate simple Weighting Potential based on a **sensor model file**

```
generate_potential --model Sensor.conf --binning 300,300,100 --matrix 3,3 --output WP --init
```

type = "monolithic"

number\_of\_pixels = 3 3

pixel\_size = 20um 20um

implant\_size = .9um .9um

sensor\_thickness = 10um

# generate\_potential Tool



This tool allows to generate simple Weighting Potential based on a **sensor model file**

```
generate_potential --model Sensor.conf --binning 300,300,100 --matrix 3,3 --output WP --init
```

```
type = "monolithic"  
  
number_of_pixels = 3 3  
pixel_size = 20um 20um  
implant_size = .9um .9um  
sensor_thickness = 10um
```

```
Allpix Squared v2.3.2 Weighting Potential Generator  
internal ##EVENTS##  
##TURN## ##TILT## 1.0  
0.0 0.0 0.0  
10 60 60 0.0 0.0 0.0 0.0 300 300 100 0.0  
1 1 1 1.59266e-05  
1 1 2 1.61061e-05  
1 1 3 1.6285e-05  
1 1 4 1.64629e-05  
1 1 5 1.66394e-05  
1 1 6 1.68143e-05
```



# [WeightingPotentialReader]



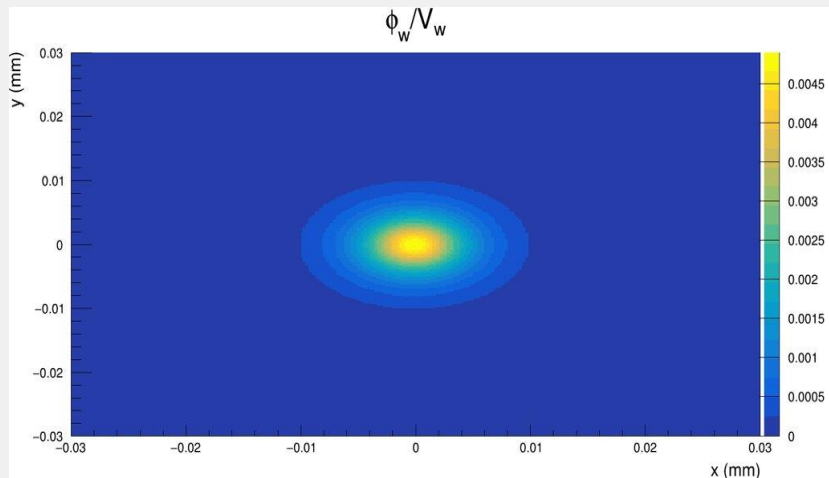
It takes adaptative meshes from finite element simulations like TCAD to **regularly space grids** for faster look up of the fields values

```
[WeightingPotentialReader]
model = "mesh"
file_name = "WP.apf" or "WP.init"
field_scale= 3 3 #Odd number
```

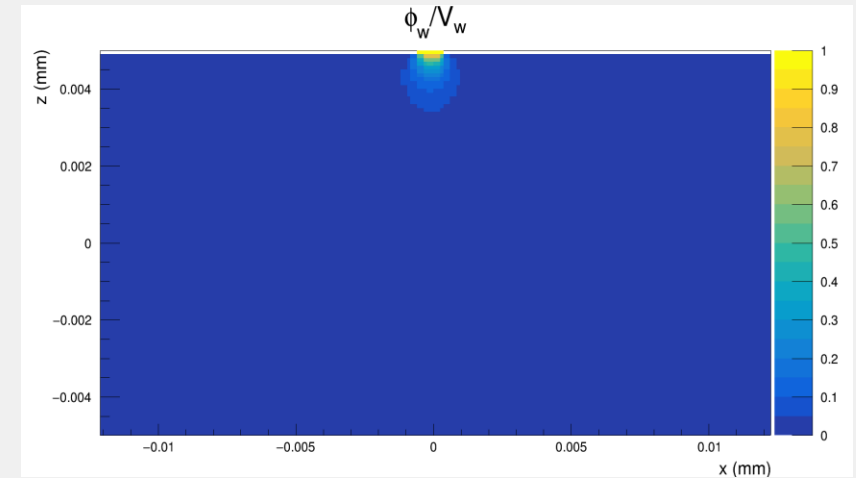
## Models

"Mesh"

**generate\_potential**



Upper view of WP (of a 20x20um<sup>2</sup> pitch pixel and 10um thickness)



Transversal cut of WP (of a 20x20um<sup>2</sup> pitch pixel and 10um thickness)

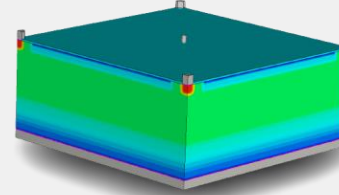
# mesh\_converter Tool

It takes adaptative meshes from finite element simulations like TCAD to **regularly space grids** for faster look up of the fields values



```
model = "init"  
region = "si-bulk"  
dimension=3  
observable = ElectrostaticPotential  
observable_units = ""  
divisions = 300 300 100  
initial_radius = 0.01  
xyz= x y -z  
workers = 10
```

# SYNOPSYS®



*.grd & .dat*



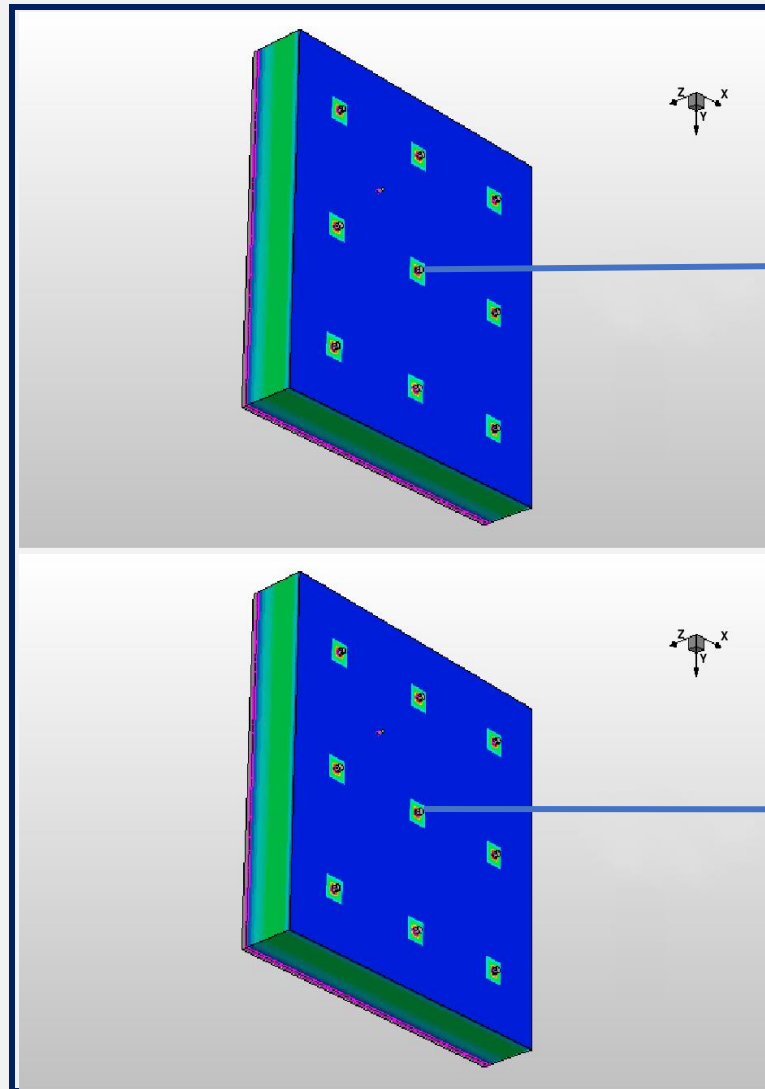
*mesh\_converter*

```
Allpix Squared v2.3.2 Weighting Potential  
Generator  
internal ##EVENTS##  
##TURN## ##TILT## 1.0  
0.0 0.0 0.0  
10 60 60 0.0 0.0 0.0 0.0 300 300 100 0.0  
1 1 1 0  
1 1 2 0  
1 1 3 0  
1 1 4 0  
1 1 5 0  
1 1 6 0
```

# Weighting Potential

How to obtain it?

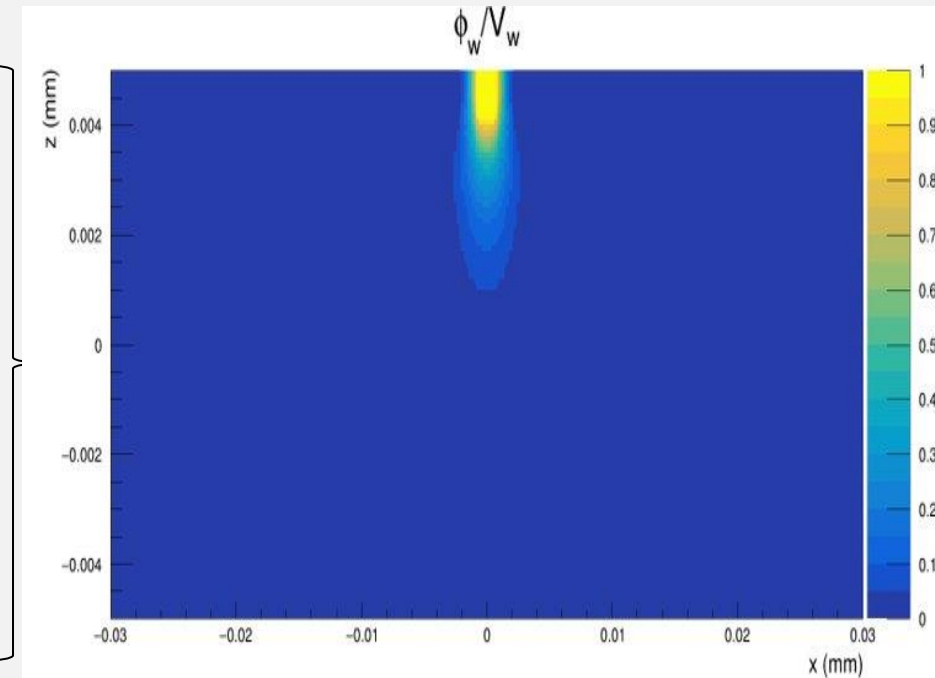
1. Simulate **Electrostatic Potential** with TCAD at the collection electrode for two slightly different voltages
2. Subtract the two electrostatic potentials at every mesh point
3. Divide by the collection electrode voltage difference



i.e. Voltage: -1.2 V

$$(\phi_1 - \phi_2) / \Delta U$$

i.e. Voltage: -1.3 V



High weighting potential values are concentrated around collection electrode

# [WeightingPotentialReader]

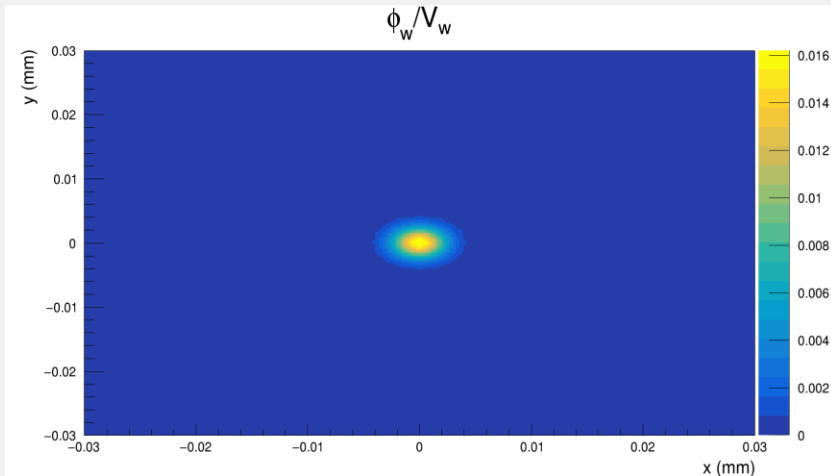
Adds a weighting potential (Ramo potential) to the detector from one of the supported sources. This module support **two types of weighting potentials**.



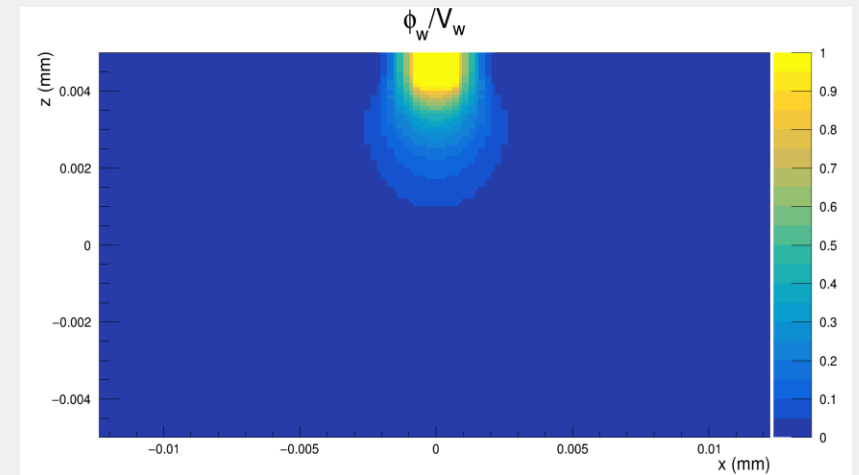
```
[WeightingPotentialReader]  
model = "pad"  
output_plots=true  
field_scale= 3 3 #Odd number
```

## Models

"Mesh"



Upper view of WP (of a 20x20um<sup>2</sup> pitch pixel and 10um thickness)



Transversal cut of WP (of a 20x20um<sup>2</sup> pitch pixel and 10um thickness)

# [TransientPropagation] Module



Simulates the transport of electrons and holes through the sensitive sensor volume of the detector.

For each step of the simulation, the induced charge on the neighboring pixel implants is calculated via the Shockley-Ramo theorem

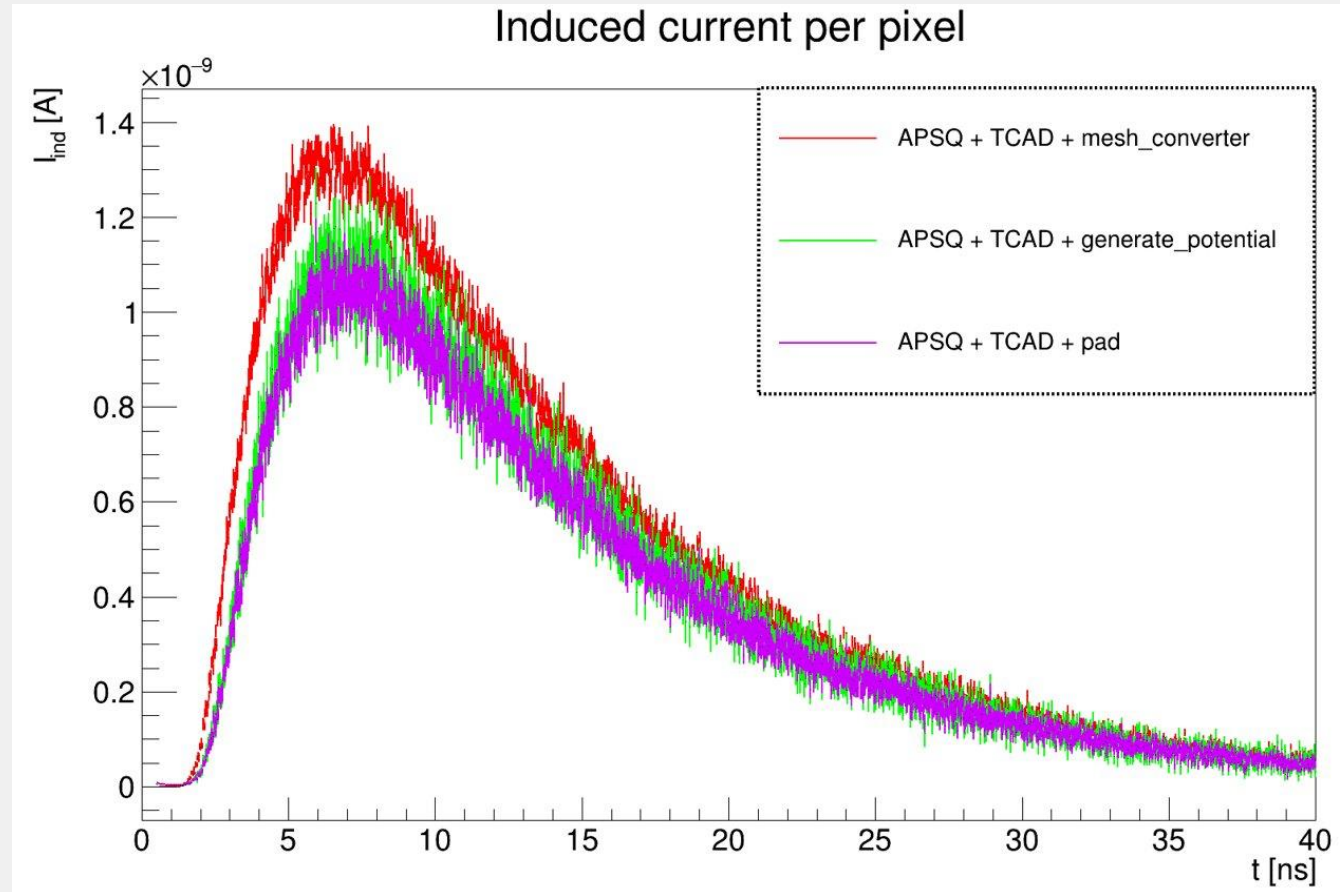
```
[TransientPropagation]
mobility_model="masetti_canali"
recombination_model="srh_auger"
temperature = 293K
charge_per_step = 1
output_plots = true
timestep = 7ps
integration_time = 40ns
induction_matrix = 3,3
```

# [TransientPropagation] Module

Simulates the transport of electrons and holes through the sensitive sensor volume of the detector.

For each step of the simulation, the induced charge on the neighboring pixel implants is calculated via the Shockley-Ramo theorem

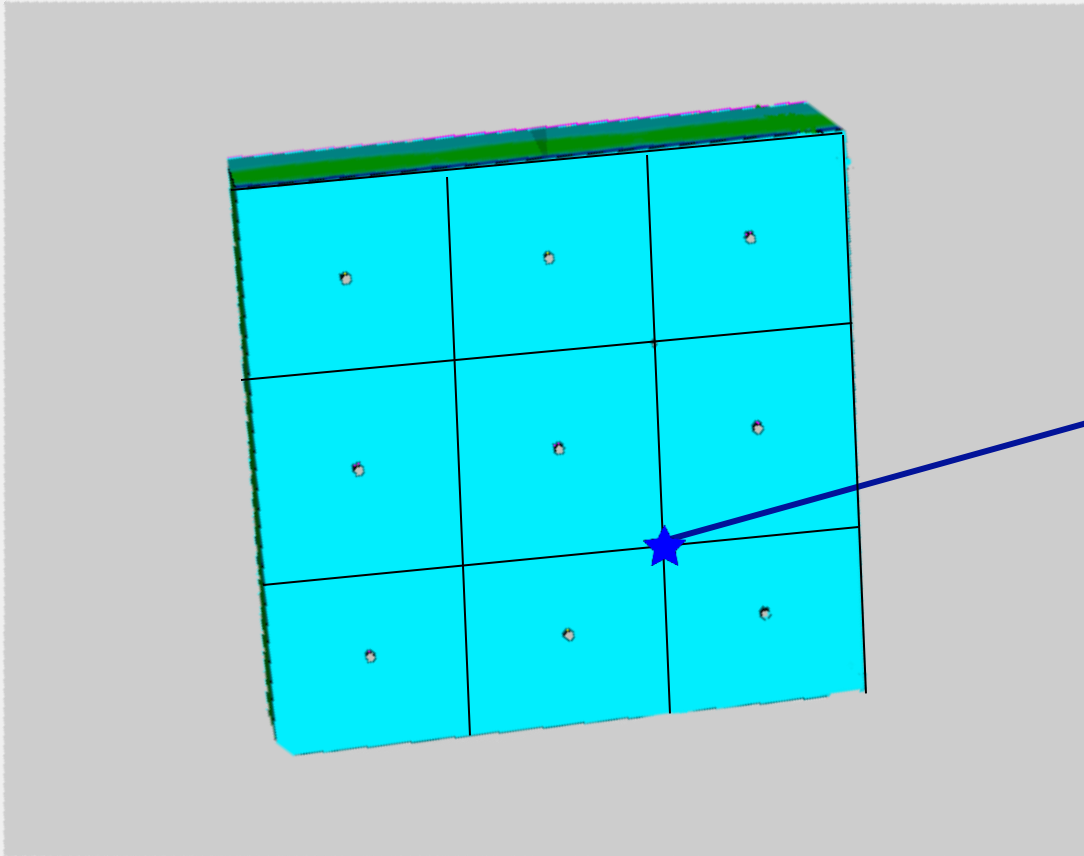
```
[TransientPropagation]
mobility_model="masetti_canali"
recombination_model="srh_auger"
temperature = 293K
charge_per_step = 1
output_plots = true
timestep = 7ps
integration_time = 40ns
induction_matrix = 3,3
```



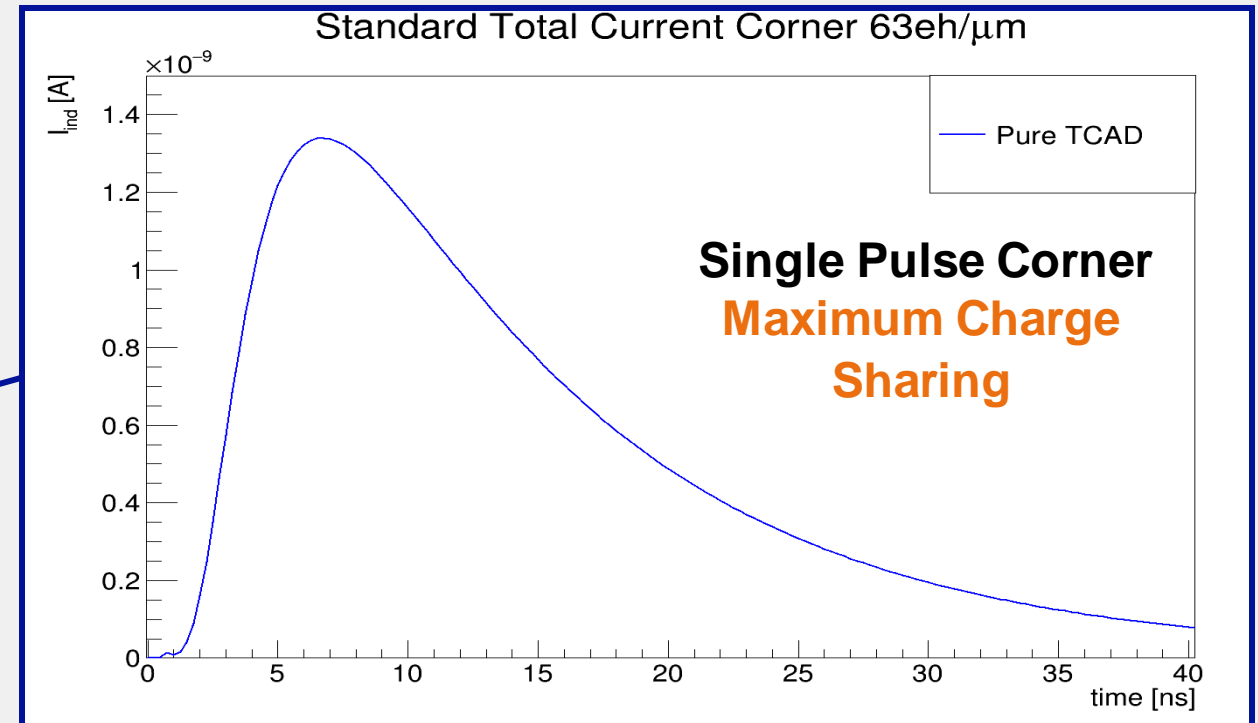
# Pure TCAD Simulations

## Extreme case under study

- Charge carriers injected alongside the pixel **corner**
- Fixed amount of charge carriers: **Linear Energy Transfer (LET) 63 eh/μm**



**3x3-cell model**



# Validation with TCAD

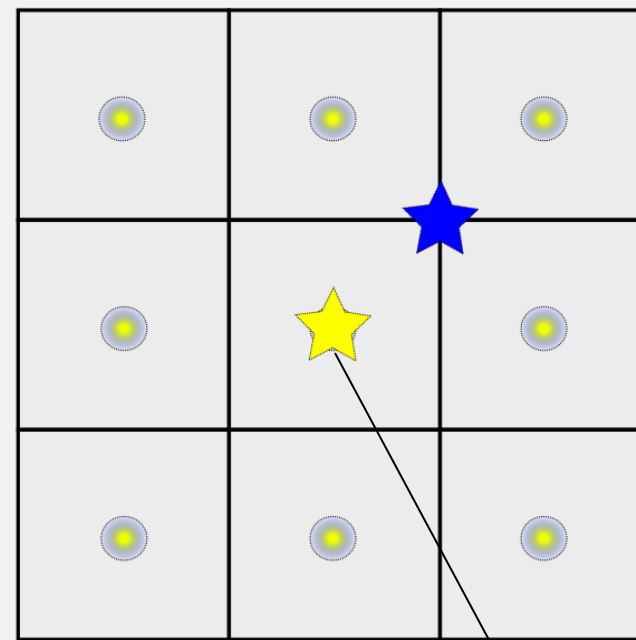
## TCAD + APSQ


- To **validate TCAD+APSQ simulations**, same simulation conditions as in transient TCAD are replicated:
  - Charge carriers injected alongside the pixel **corner**
  - Fixed amount of charge carriers: **Linear Energy Transfer (LET) 63 eh/ $\mu\text{m}$**
  - Only the epitaxial layer is simulated: **10  $\mu\text{m}$**
  - Simulation repeated **1000x** times and the average pulse is calculated


### Simulation Time


TCAD ~ **days (Single Pulse)**

TCAD + APSQ ~ **hours**



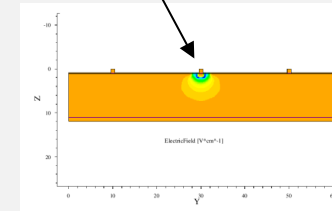
 Charge injection at the **corner**

 Charge injection at the **center**

 Collection Electrode at +1.2 V

P-Well and P-Substrate at -1.4 V

3x3 pixel matrix  
20x20  $\mu\text{m}^2$  pitch



High weighting potential values are concentrated around collection electrode

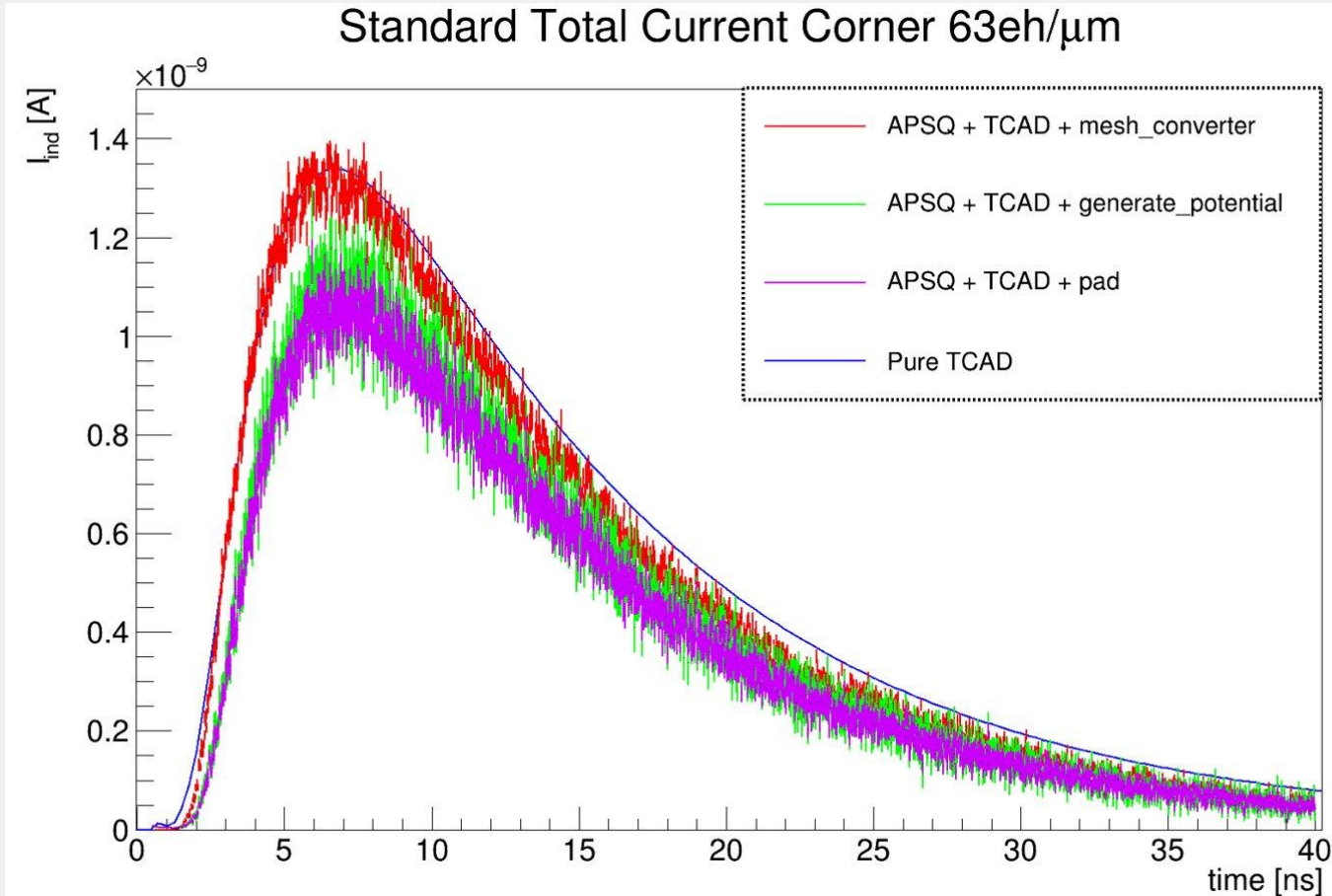
## Motivation of TCAD+APSQ

High statistics and Geant4 enable the inclusion of Landau fluctuations, which offers a more realistic simulation scenario

**But first we have to validate it!**



# Comparison with TCAD



Comparison of the 3 different methods to produce a weighting field to integrate with Allpix Squared

- Similar pulse shape and pulse duration
- Good agreement with TCAD simulation

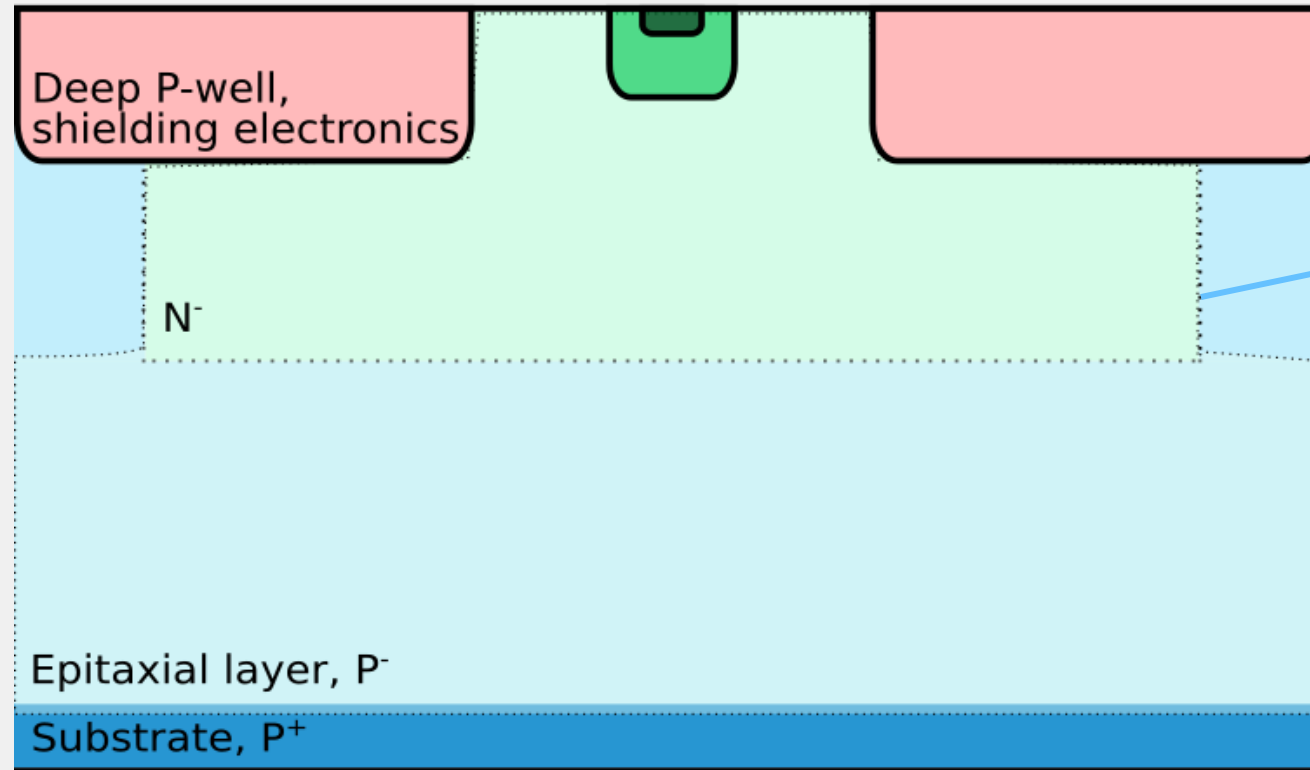
**Simulation time (using 15 cores):**

- mesh\_converter ~ 8 minutes
- generate\_potential ~ 8 minutes
- pad ~ 6 hours

# Monolithic Active Pixel Sensors (MAPS)

## N-Gap

N-well collection  
electrode



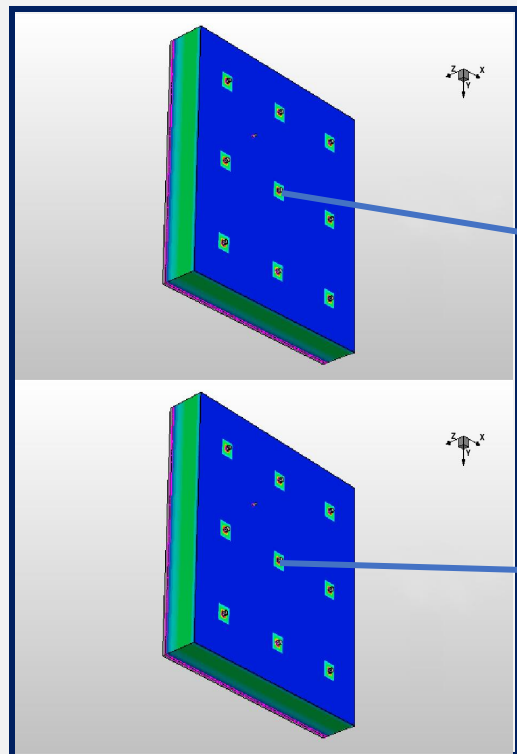
Gap in Continuous  
N-type Implant

Speed up charge  
collection

M. Minker et al 2019 JINST 14

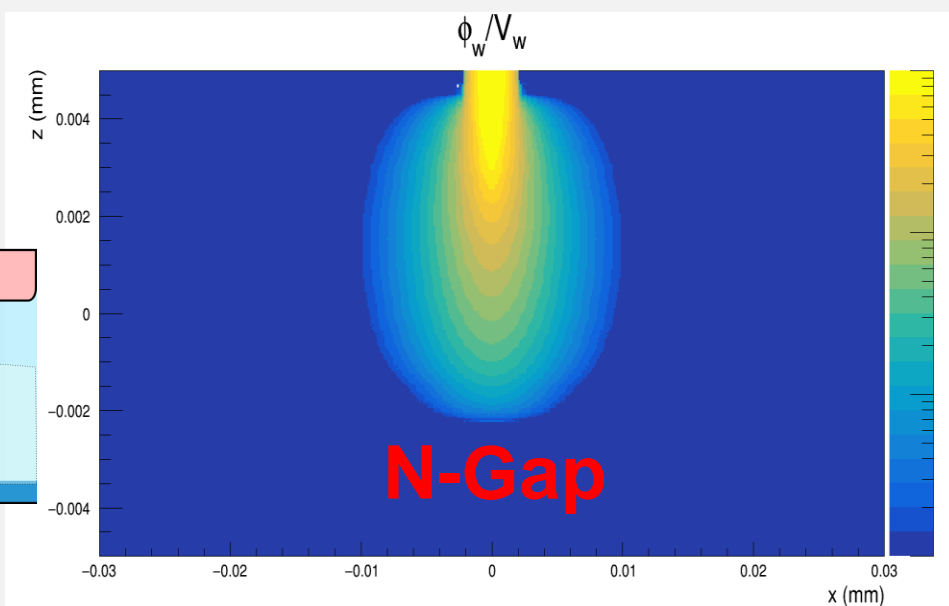
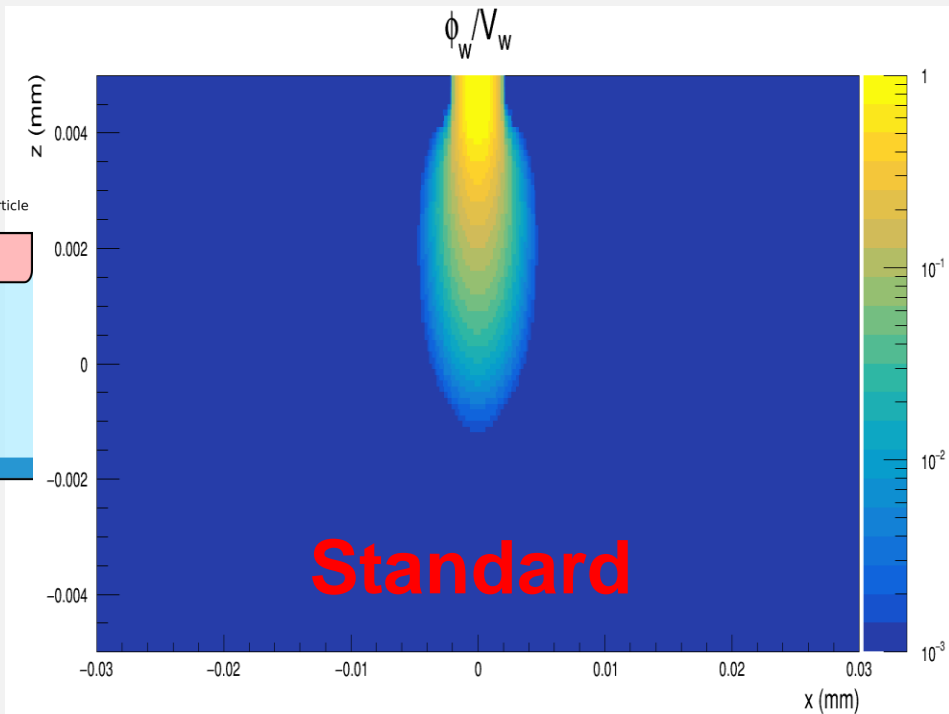
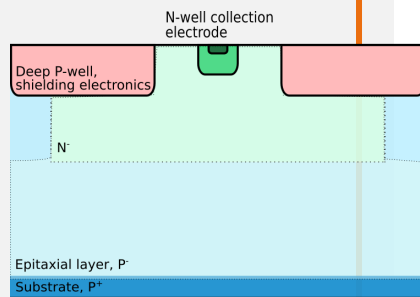
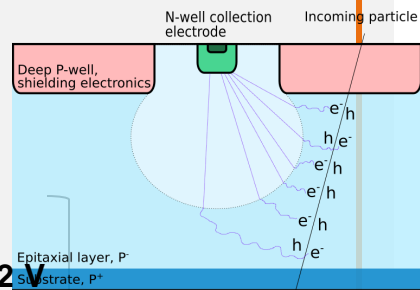
# Weighting Potential $(\phi_1 - \phi_2)/\Delta U$

How to obtain it?



i.e. Voltage: -1.2V

i.e. Voltage: -1.3 V

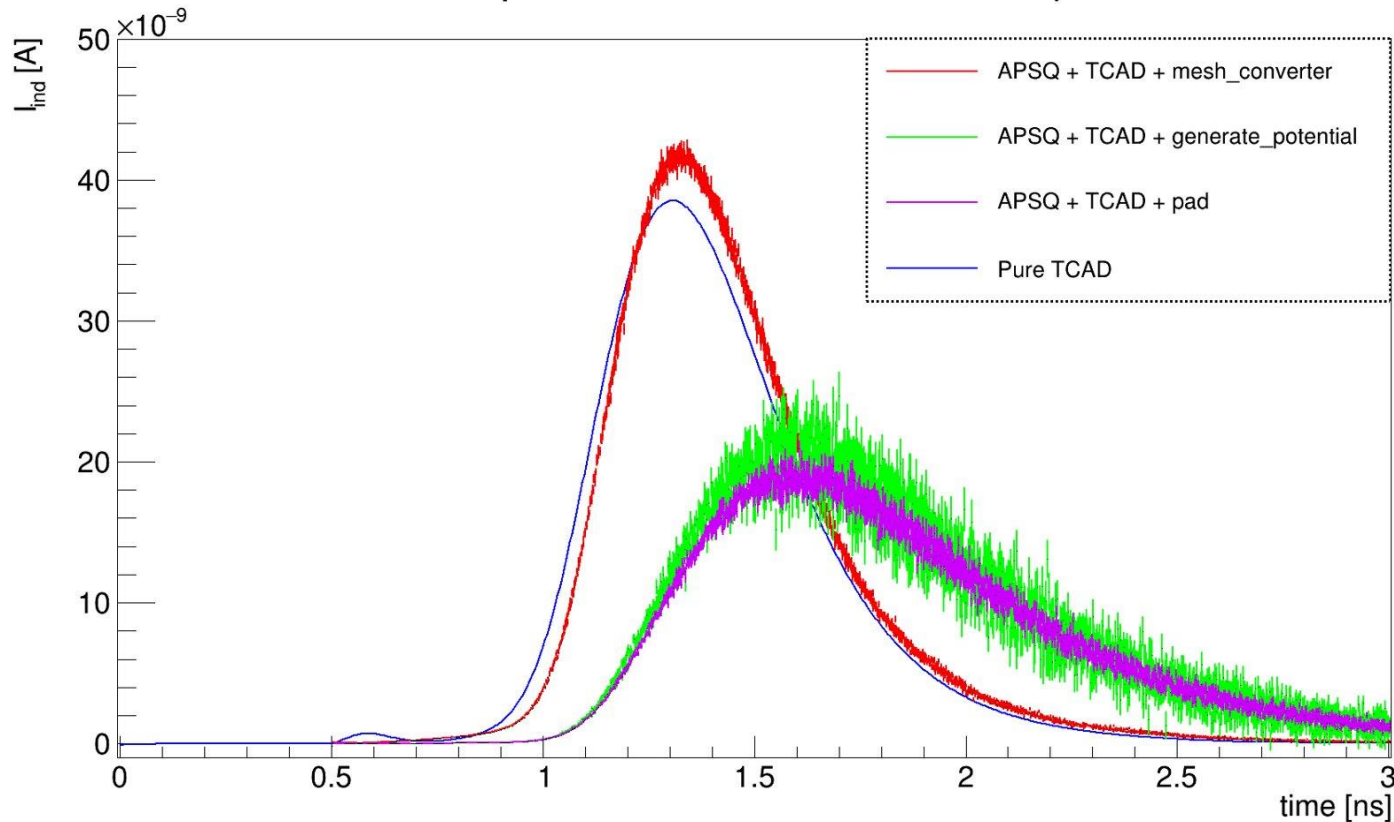


**Only Geometry dependent!**  
So it remains the same for other voltages

# Comparison with TCAD



N-Gap Total Current Corner 63eh/ $\mu\text{m}$



Comparison of the 3 different methods to produce a weighting field to integrate with Allpix Squared

- Good agreement with TCAD simulation (**mesh\_converter**)
- Other methods too simplistic to accurately reproduce TCAD results

**Simulation time (using 15 cores):**  
mesh\_converter ~ 6 minutes  
generate\_potential ~ 6 minutes  
pad ~ 4 hours

# Summary

## Simple Geometry Sensors

- Good agreement in pulse shape and duration between approaches
- generate\_potential tool simple to use and good for simulation time

## More complicated Geometry Sensors

- Both pad and generate\_potential too simplistic to produce accurate results
- Tweaks to WP required
- Resort to other methods or just use TCAD profiles

# Thank you for your time!

## Contact

Manuel Alejandro Del Rio Viera  
[manuel.del.rio.viera@desy.de](mailto:manuel.del.rio.viera@desy.de)

HELMHOLTZ

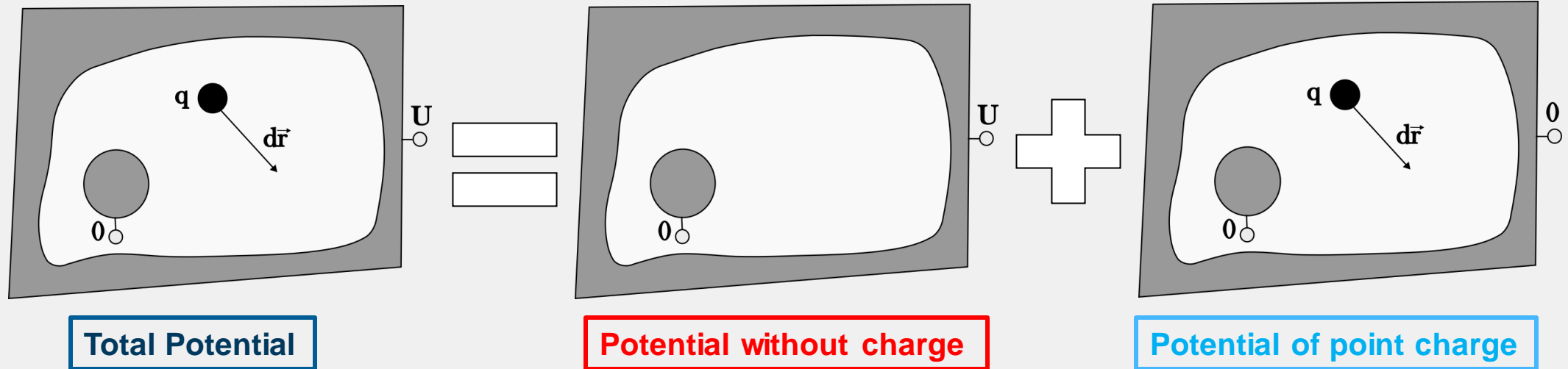


# Backup

# Weighting Field: Shockley-Ramo Theorem

## Basic Principle of Induced Signal in an electrode

See academic training lecture by W. Riegler (<https://indico.cern.ch/event/843083/>)



For a **static electric field, the energy:**  $W_E = W_{E_0} + W_{E_q}$

**No change in total field energy** when charge is moving:  $0 = dW_{E_0} + dW_{E_q} = UdQ + q\vec{E}_0 \cdot d\vec{r} \rightarrow dQ = -q\frac{\vec{E}_0}{U} \cdot d\vec{r}$

Solved by a **weighting field and a weighting potential:**

$$\varphi_w = \frac{\varphi_0}{U}; \vec{E}_w = -\vec{\nabla}\varphi_w$$

The induced current can be expressed by the **propagation of the charge in the weighting field:**

$$I_{ind} = q\vec{E} \cdot \vec{v}$$

$$Q_{ind} = q(\varphi_w(\vec{r}_{t_0}) - \varphi_w(\vec{r}_t))$$



# The Tangerine Project



**Goal:** Develop the next generation of monolithic silicon pixel detectors using a 65 nm CMOS imaging process

## Requirements

- Spatial Resolution ~ 3  $\mu\text{m}$
- Time Resolution ~ 1 -10 ns
- Low material budget ~ 50  $\mu\text{m}$  silicon

**Application:**  $e^+e^-$  Colliders  

Reference detector at DESY-II test beam

- Funded by Helmholtz Innovation Pool and DESY

Part of the **Work Package 1 (WP1):** Monolithic pixel detectors in novel CMOS imaging technology

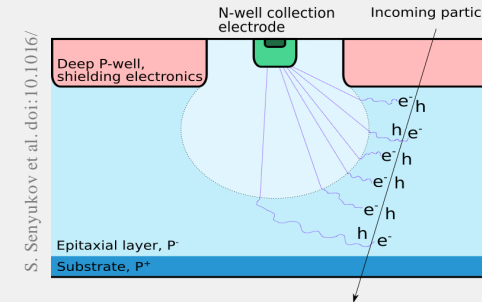
**HELMHOLTZ**

# TowArds Next GEneRation SiLicoN DEtectors



## Monolithic Active Pixel Sensors (MAPS)

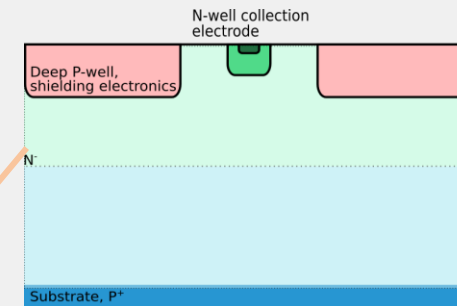
### Standard



Small Collection Electrode

### N-Blanket

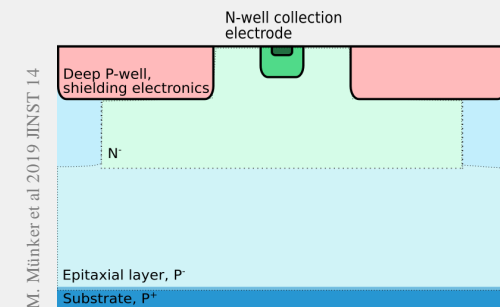
Continuous N-type Implant



Increase the depleted region

### N-Gap

Gap in Continuous N-type Implant



Speed up charge collection

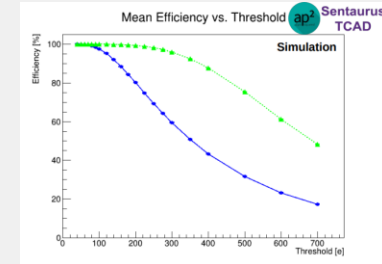
# Simulation's Workflow



## Why do we need Transient Simulations?



Compare data with simulations

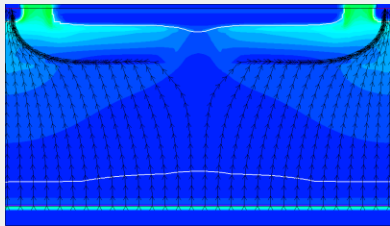


See Adriana's presentation On Simulations and Test Beam Characterization

Device Simulations (TCAD)

Monte Carlo Simulations

SYNOPSYS®



Allow to optimize the layouts that characterize a sensor

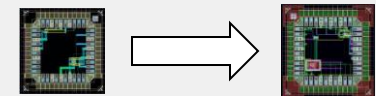
- Electric Fields
- Process Simulations
- Capacitance
- Weighting Potentials

Allow for greater statistics and to analyze detector performance

- Efficiency
- Cluster Size and Resolution
- Pulses

### Motivation of Transient Simulations

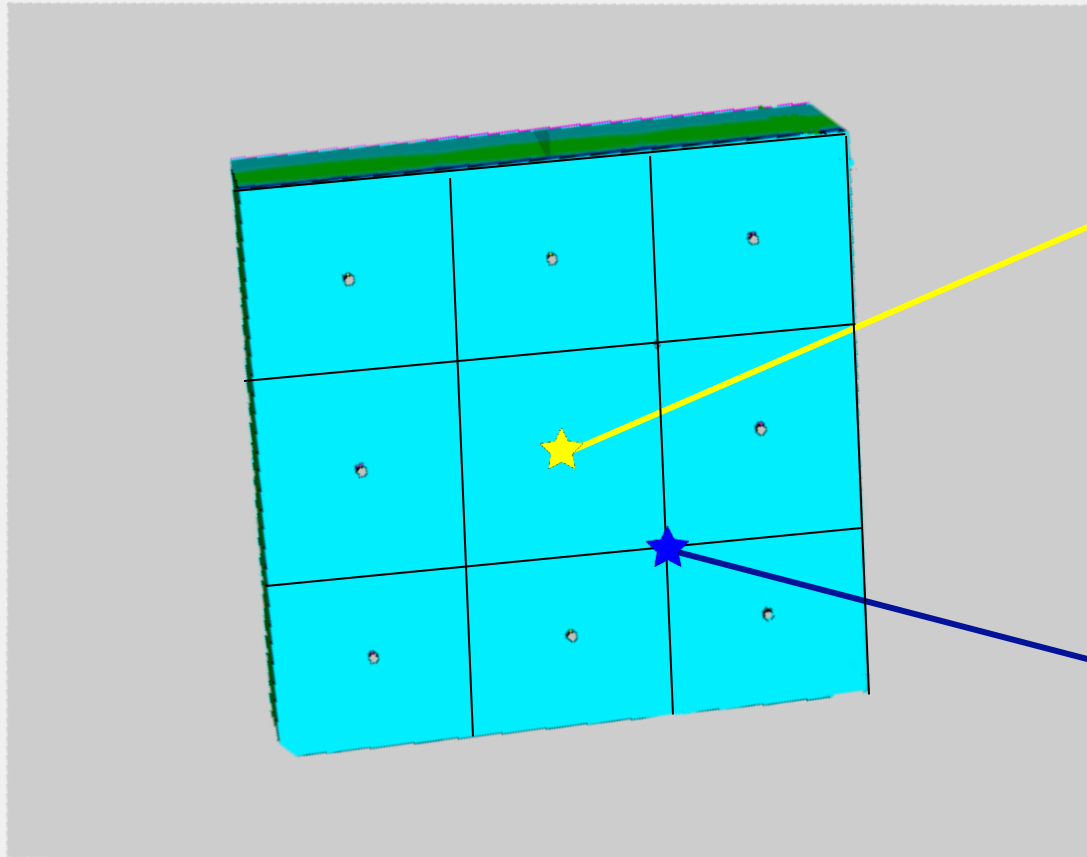
- Produce accurate pulses in more realistic simulations
- Predict sensor and precise FE response
- Optimize our sensors.



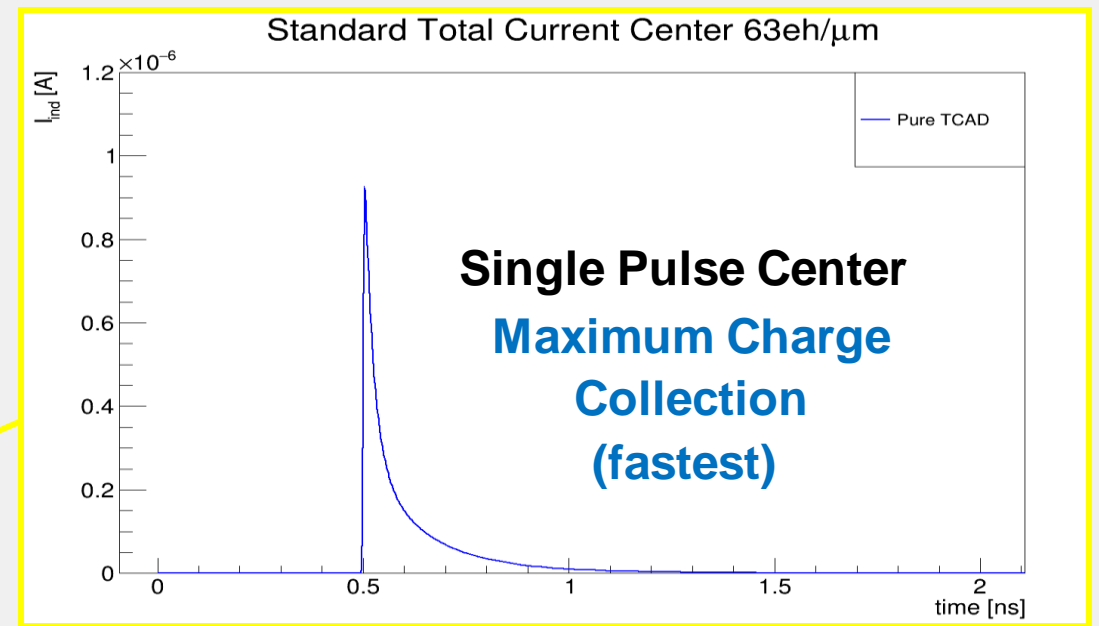
# Pure TCAD Simulations

## Two extreme cases under study

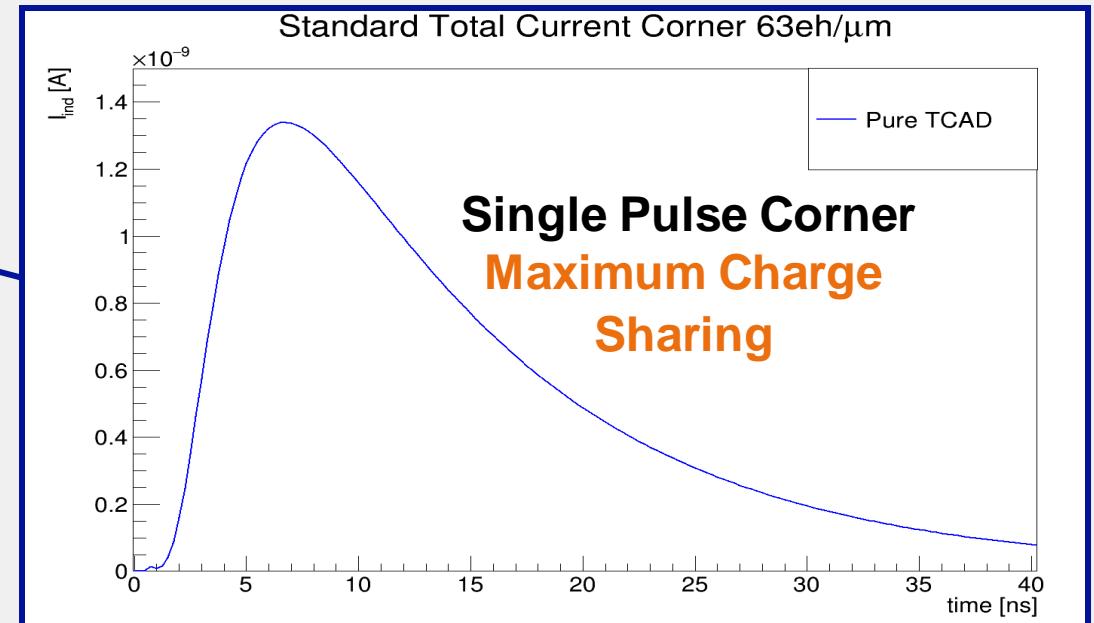
- Charge carriers injected alongside the pixel **corner** or **center**
- Fixed amount of charge carriers: **Linear Energy Transfer (LET) 63 eh/μm**



**3x3-cell model**



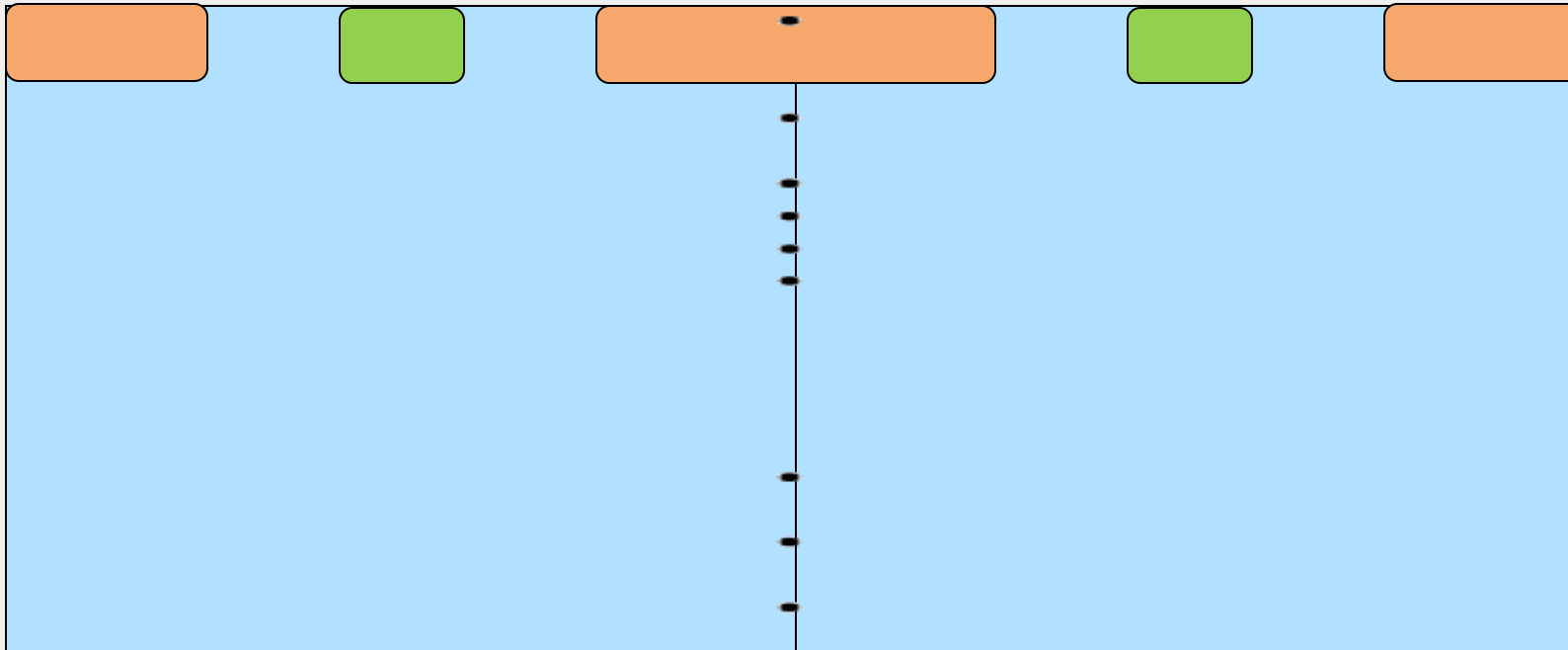
**Not same time scale!**



# Standard Linear Charge Injection

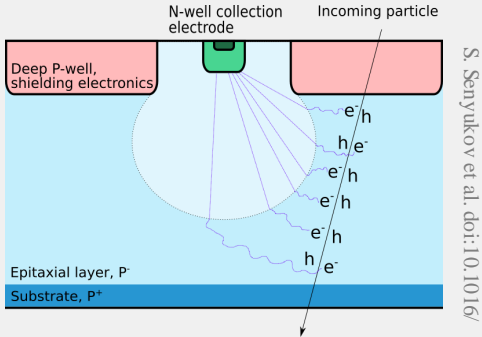
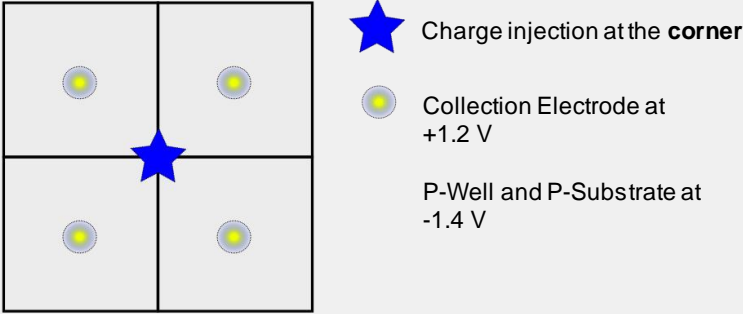
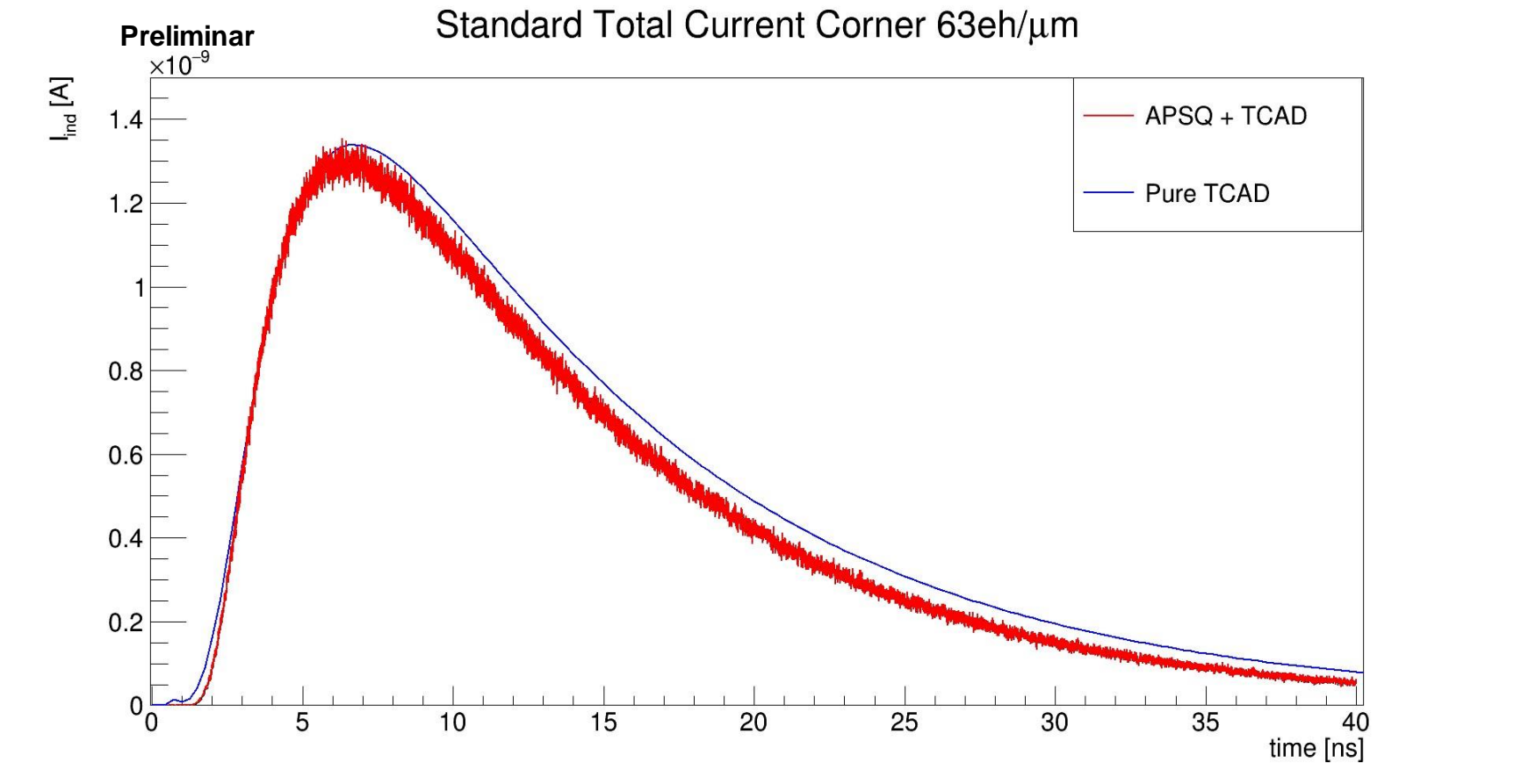
## Monolithic Active Pixel Sensors (MAPS)

Standard



# Validation – Corner Injection

## Average Pulse Comparison

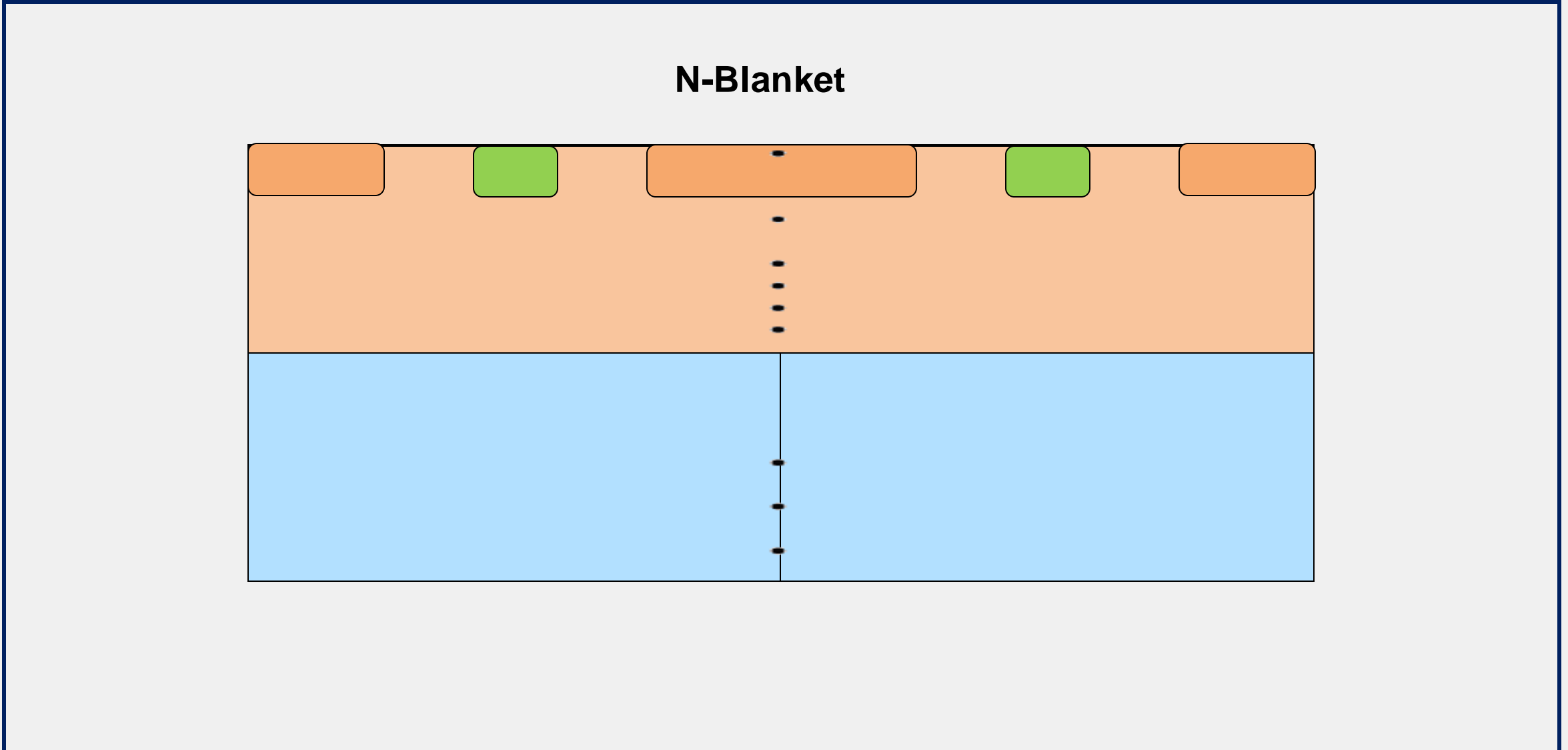


**Standard  
Pulse duration ~ 40ns**

**Pure TCAD - 1 pulse**  
**APSQ + TCAD – Average 10000 pulses**

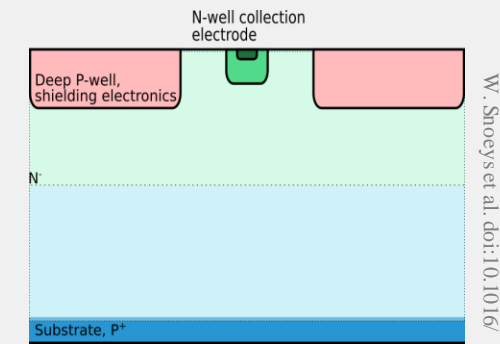
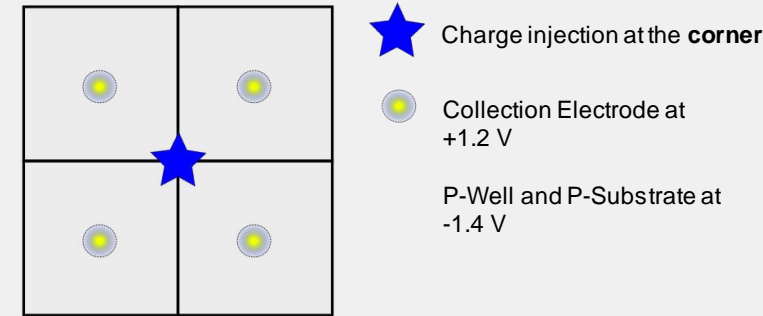
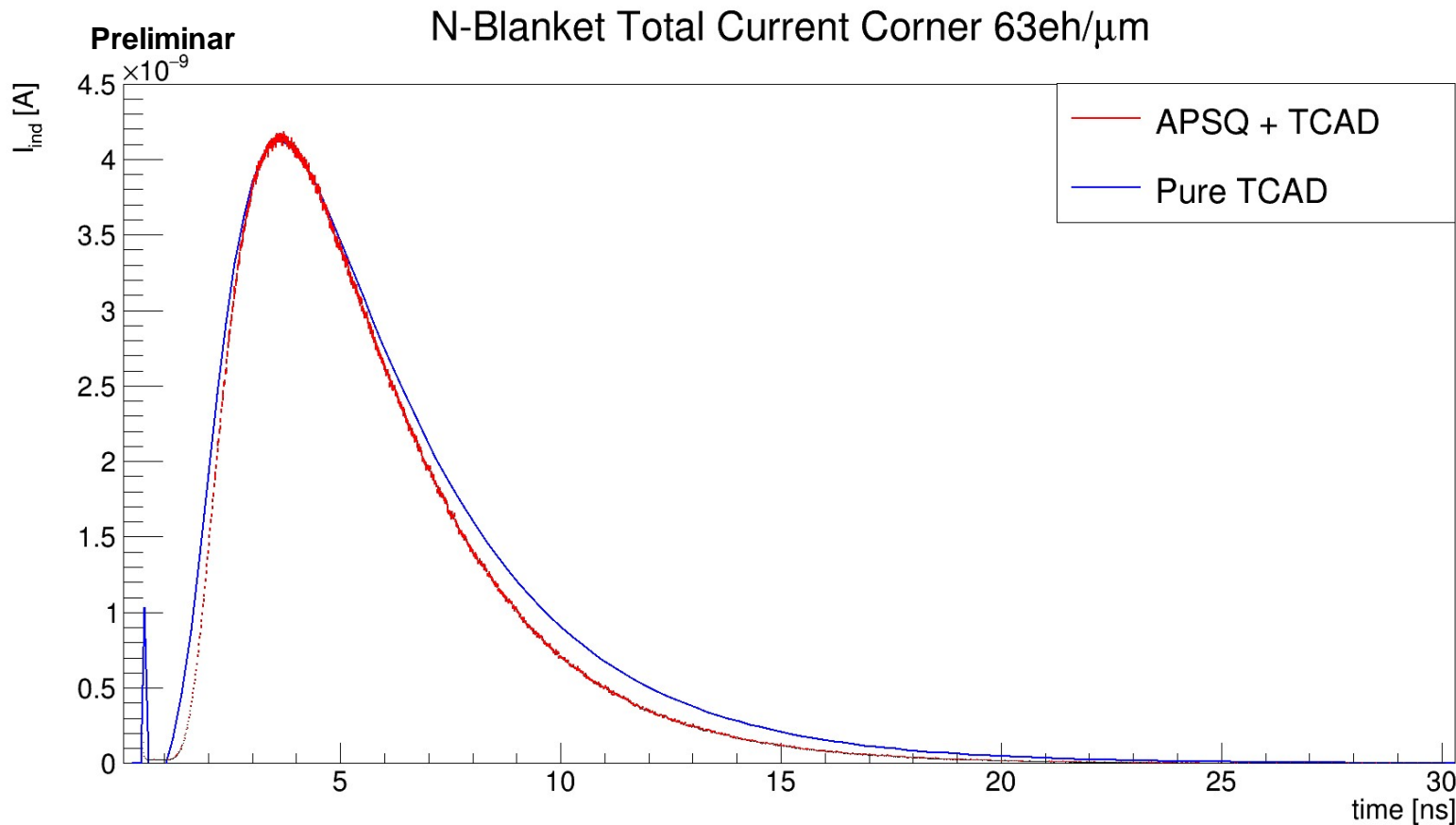
# N-Blanket Linear Charge Injection

## Monolithic Active Pixel Sensors (MAPS)



# Validation – Corner Injection

## Average Pulse Comparison

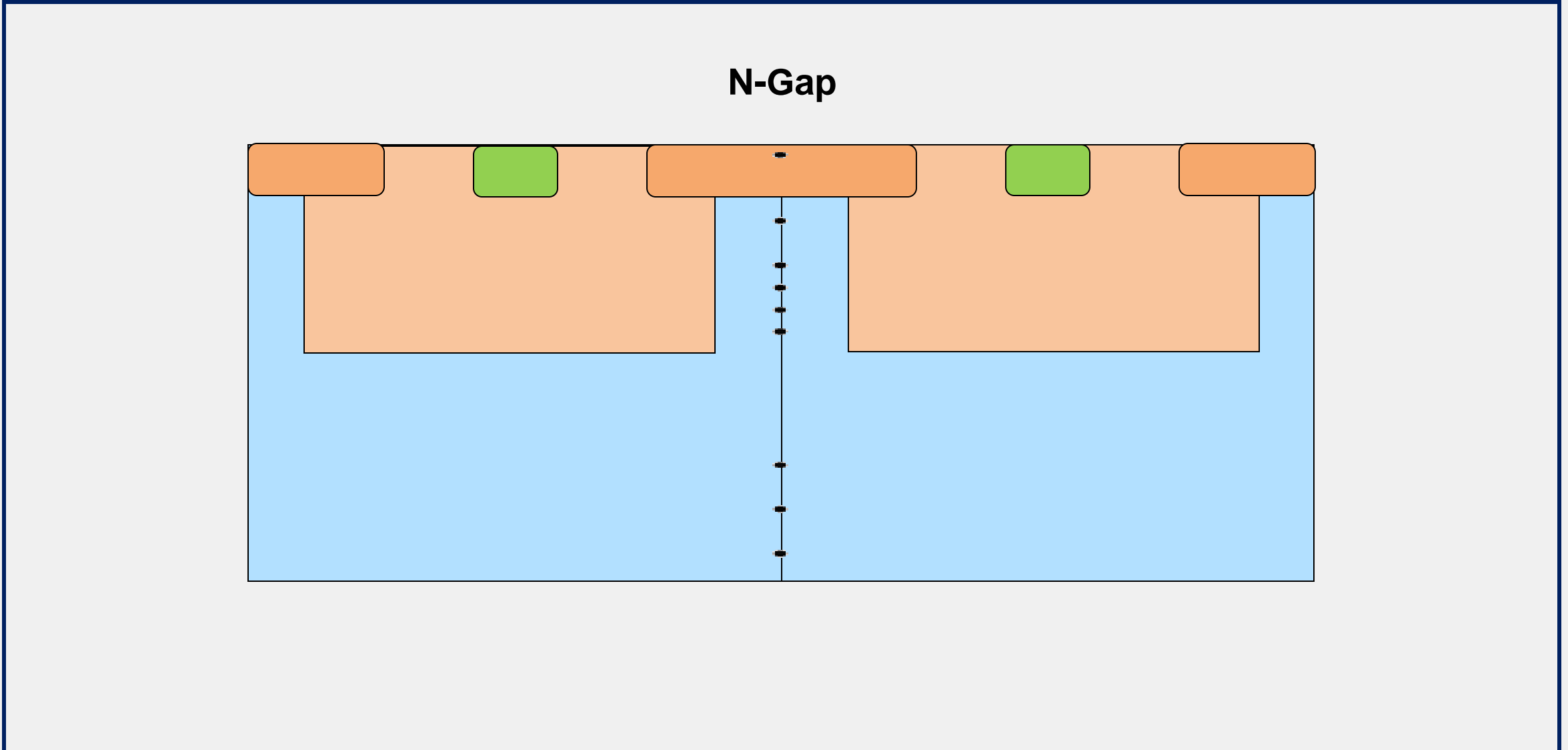


**N-Blanket**  
**Pulse duration ~ 25ns**

**Pure TCAD - 1 pulse**  
**APSQ + TCAD – Average 10000 pulses**

# N-Gap Linear Charge Injection

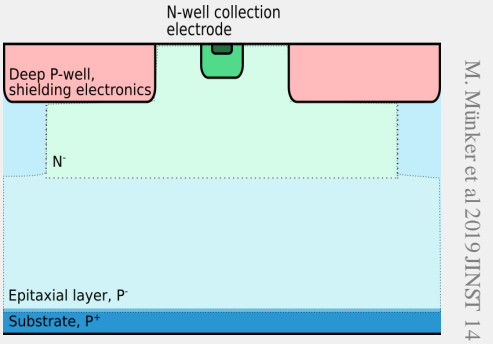
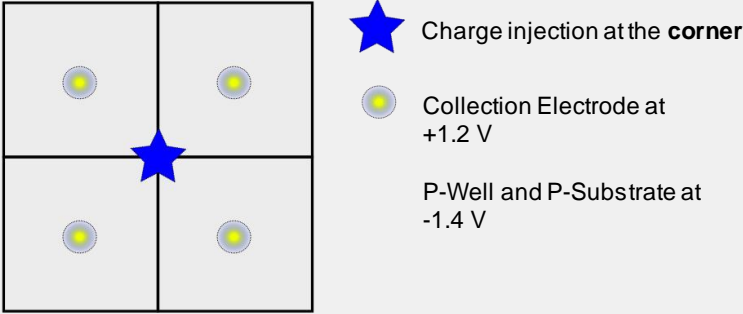
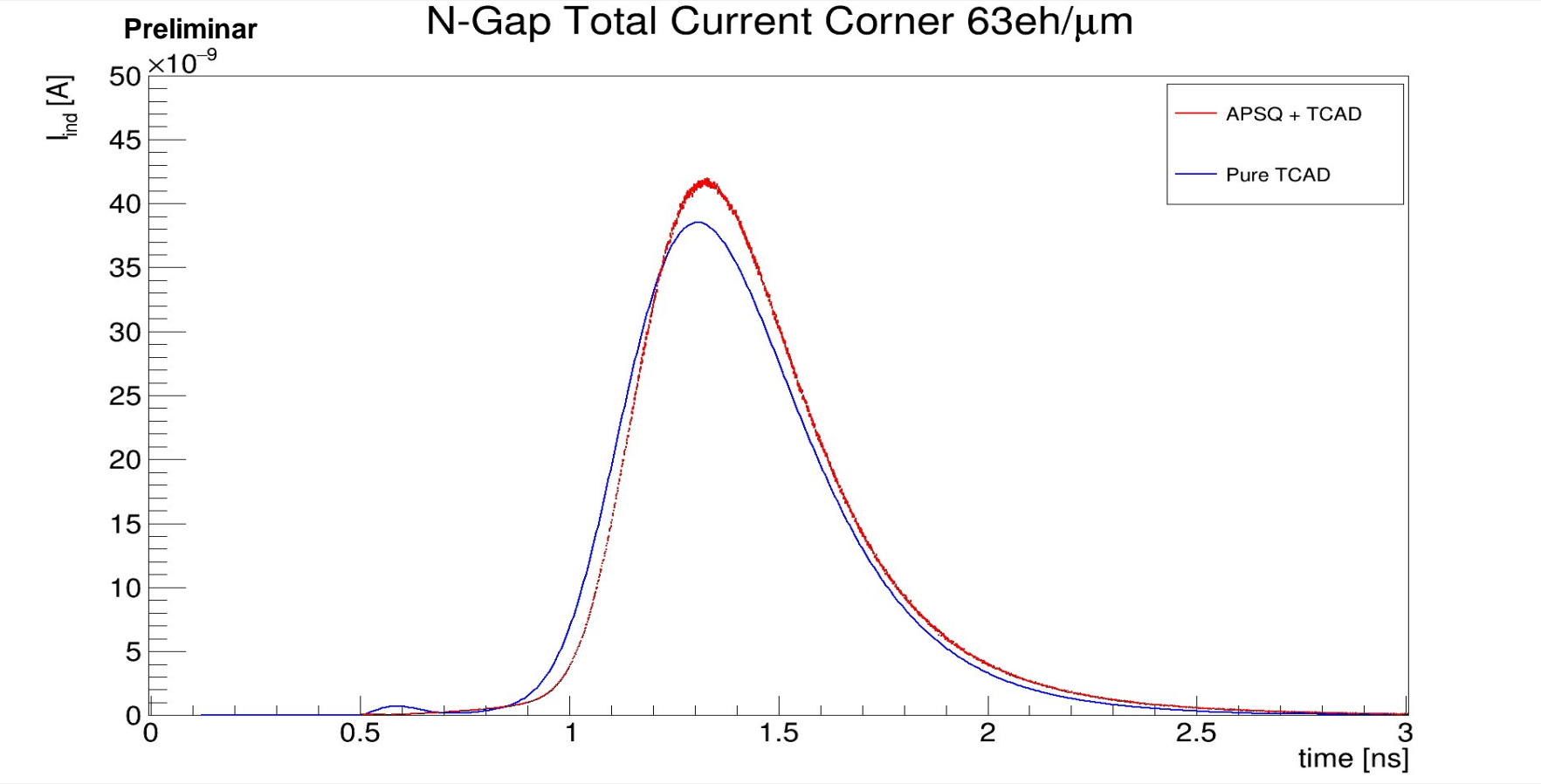
## Monolithic Active Pixel Sensors (MAPS)





# Validation – Corner Injection

## Average Pulse Comparison

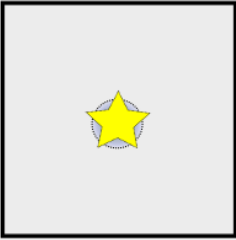
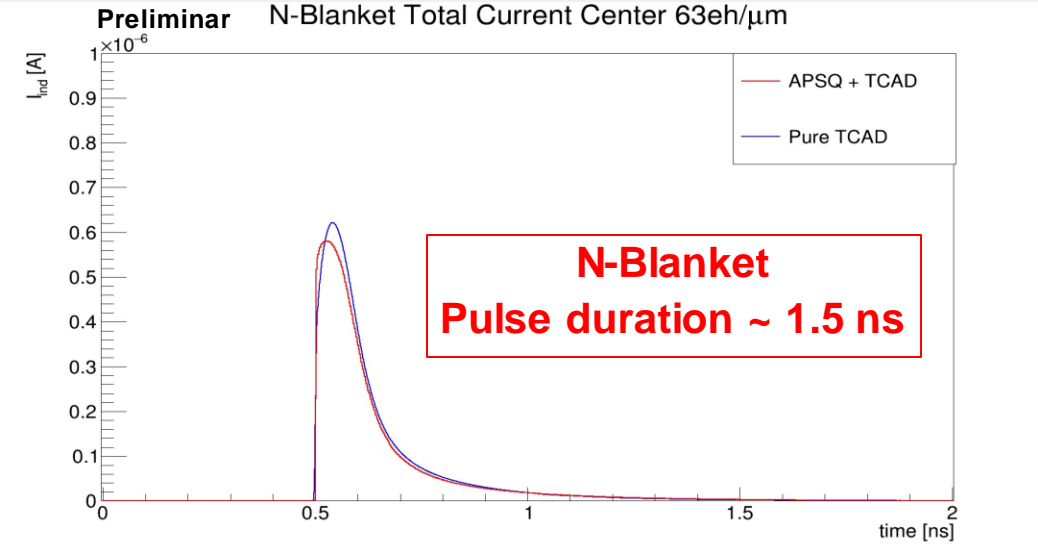
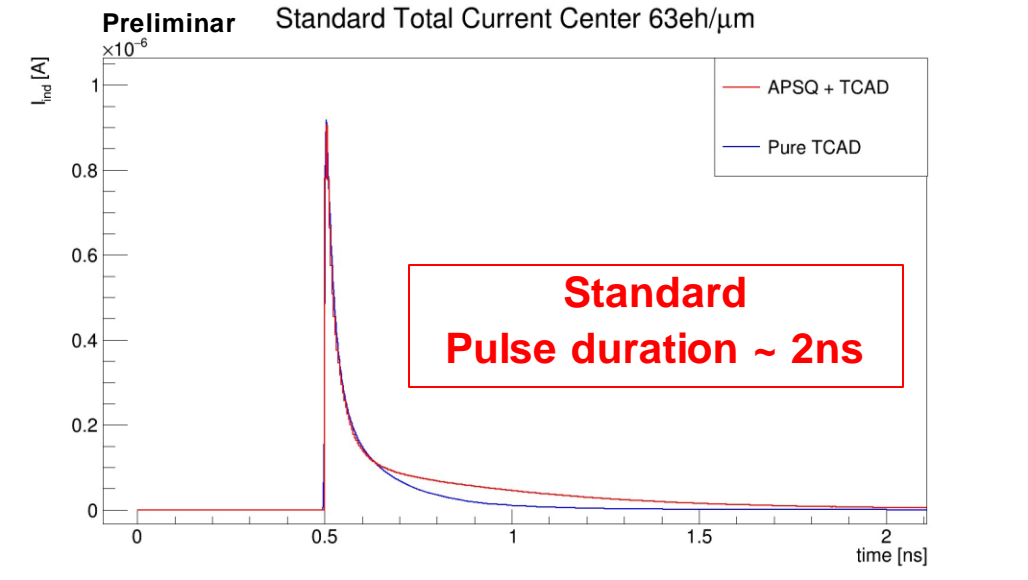


**N-Gap**  
**Pulse duration ~ 3 ns**

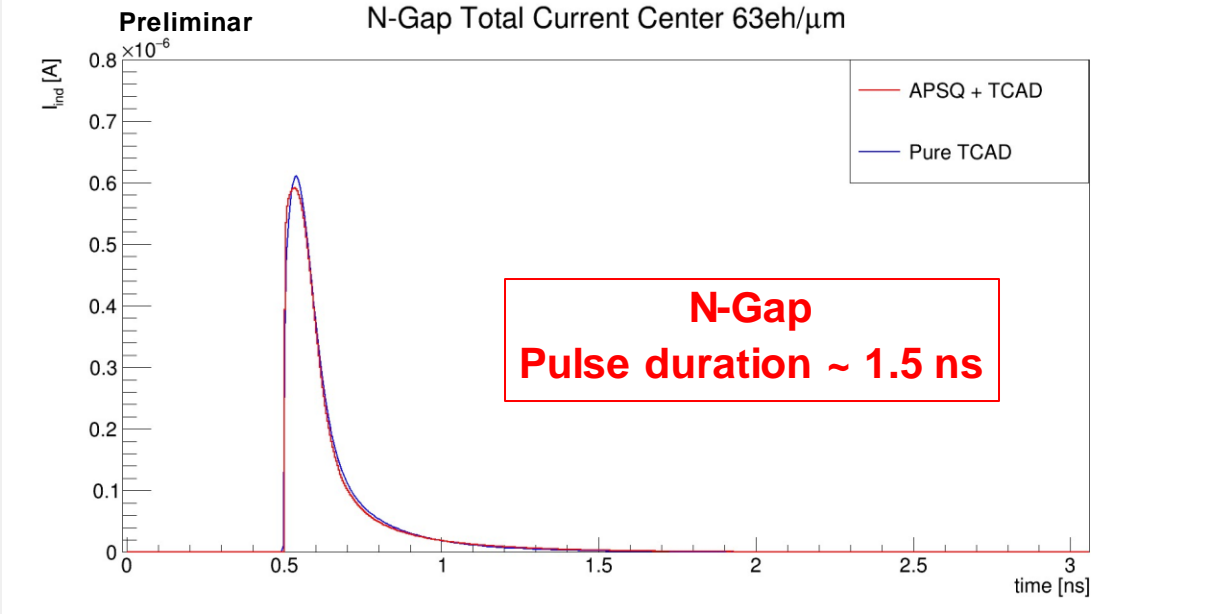
**Pure TCAD - 1 pulse**  
**APSQ + TCAD – Average 10000 pulses**

# Validation – Center Injection

## Average Pulse Comparison

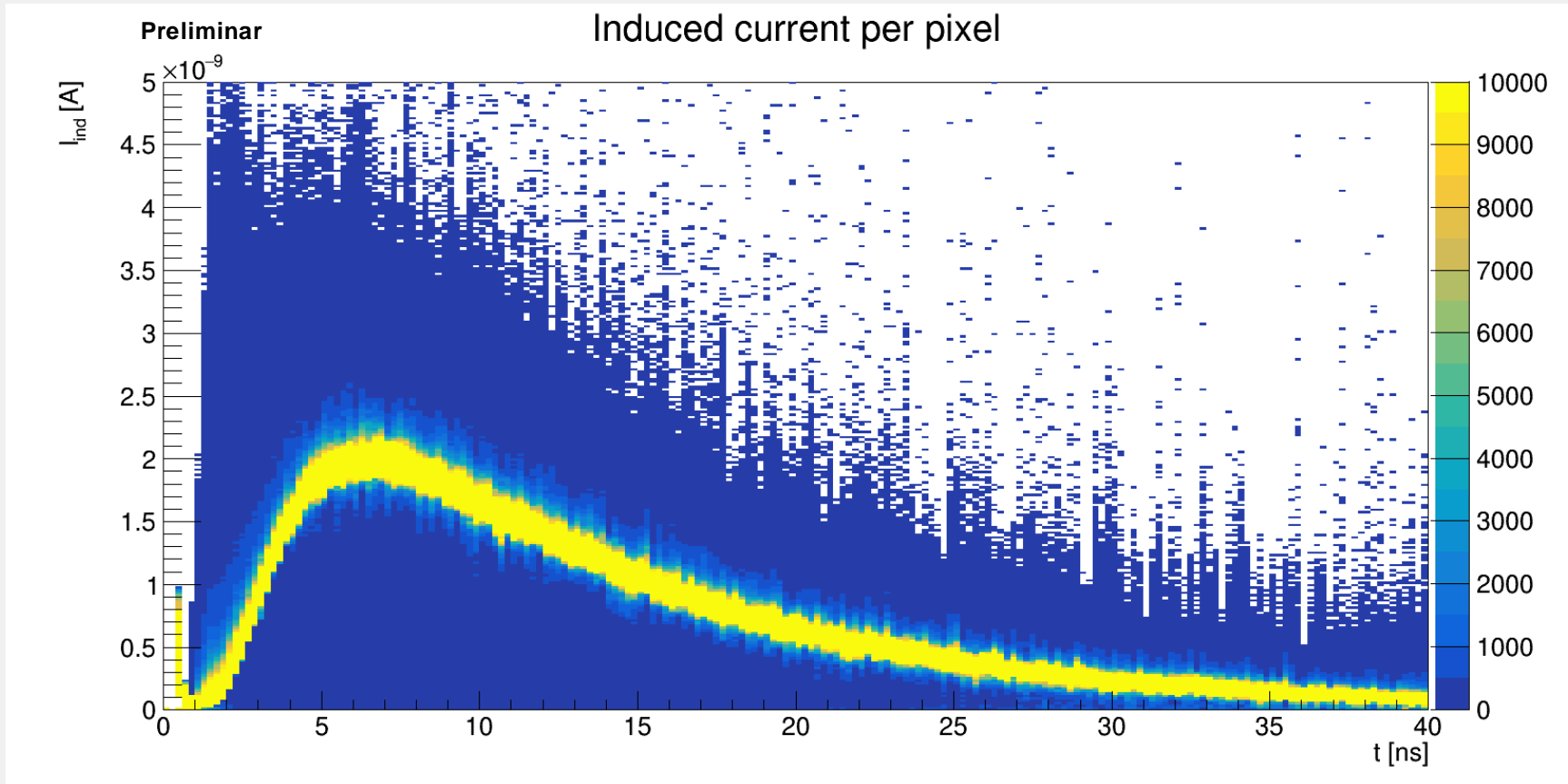


- ★ Charge injection at the **center**
- Collection Electrode at +1.2 V
- P-Well and P-Substrate at -1.4 V



Pure TCAD - 1 pulse  
APSQ + TCAD – Average 10000 pulses

# Comparison GEANT4 – Corner Injection



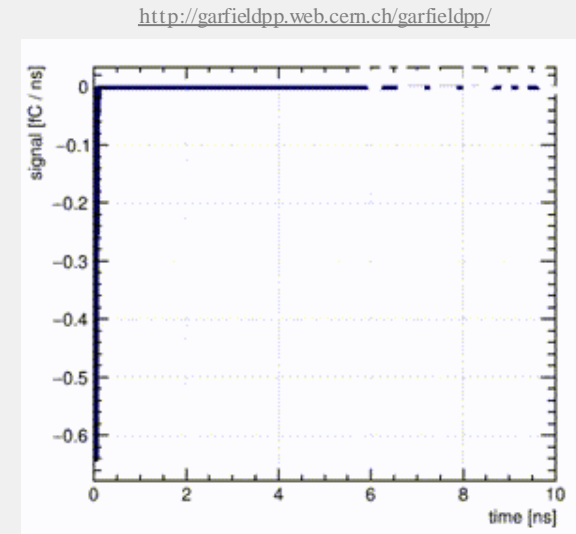
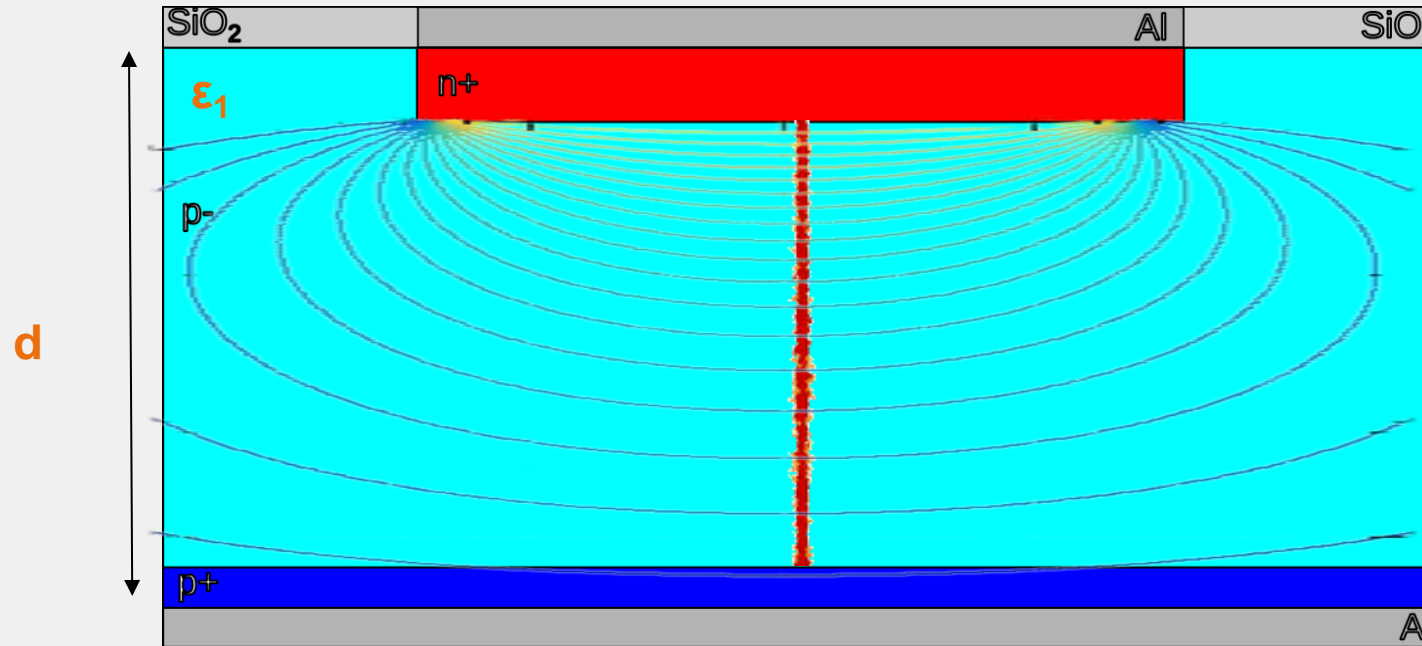
We can proceed by shooting MIP particles and thus take into account **Landau fluctuations**, **secondary particle production**, **Photoabsorbtion Ionization...**

- **Sensor and Layout Scan**
- **Timing Performance**

# Shockley-Ramo's Theorem

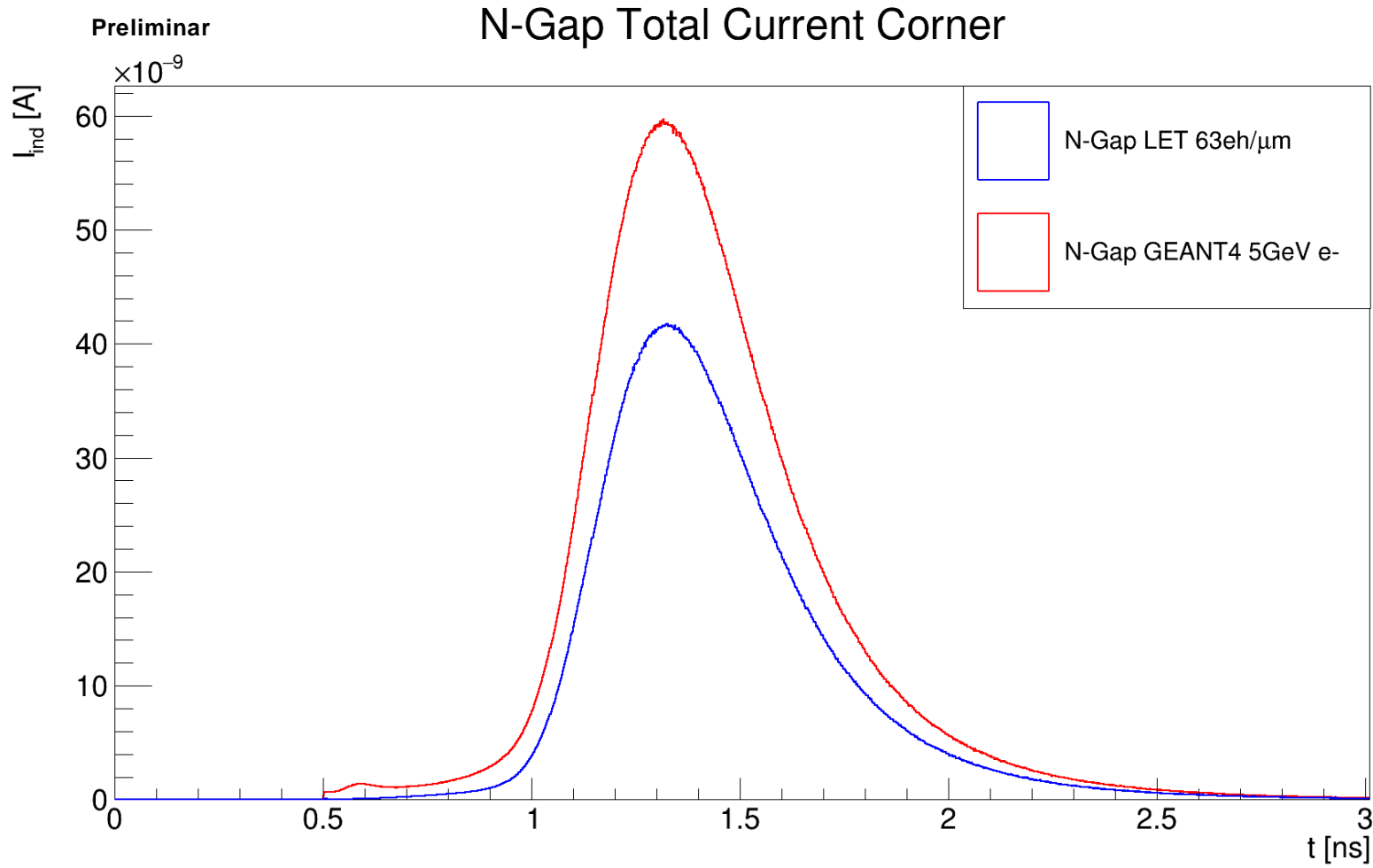
## Signal Formation on Silicon Sensors

$$I_{ind} = q\vec{E} \cdot \vec{v}$$
$$Q_{ind} = q(\varphi_w(\vec{r}_{t_0}) - \varphi_w(\vec{r}_t))$$



$$\varphi_w = \frac{\varphi_0}{U}; \vec{E}_w = -\vec{\nabla}\varphi_w$$

# Comparison GEANT4 – Corner Injection

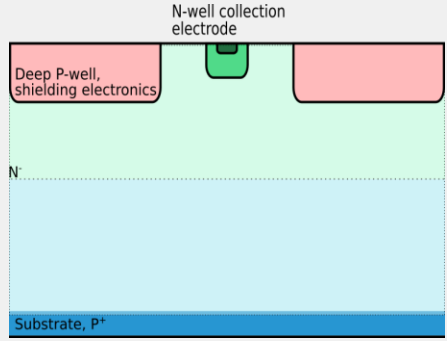
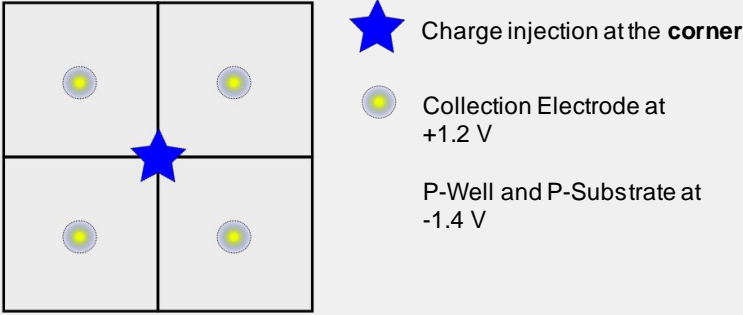
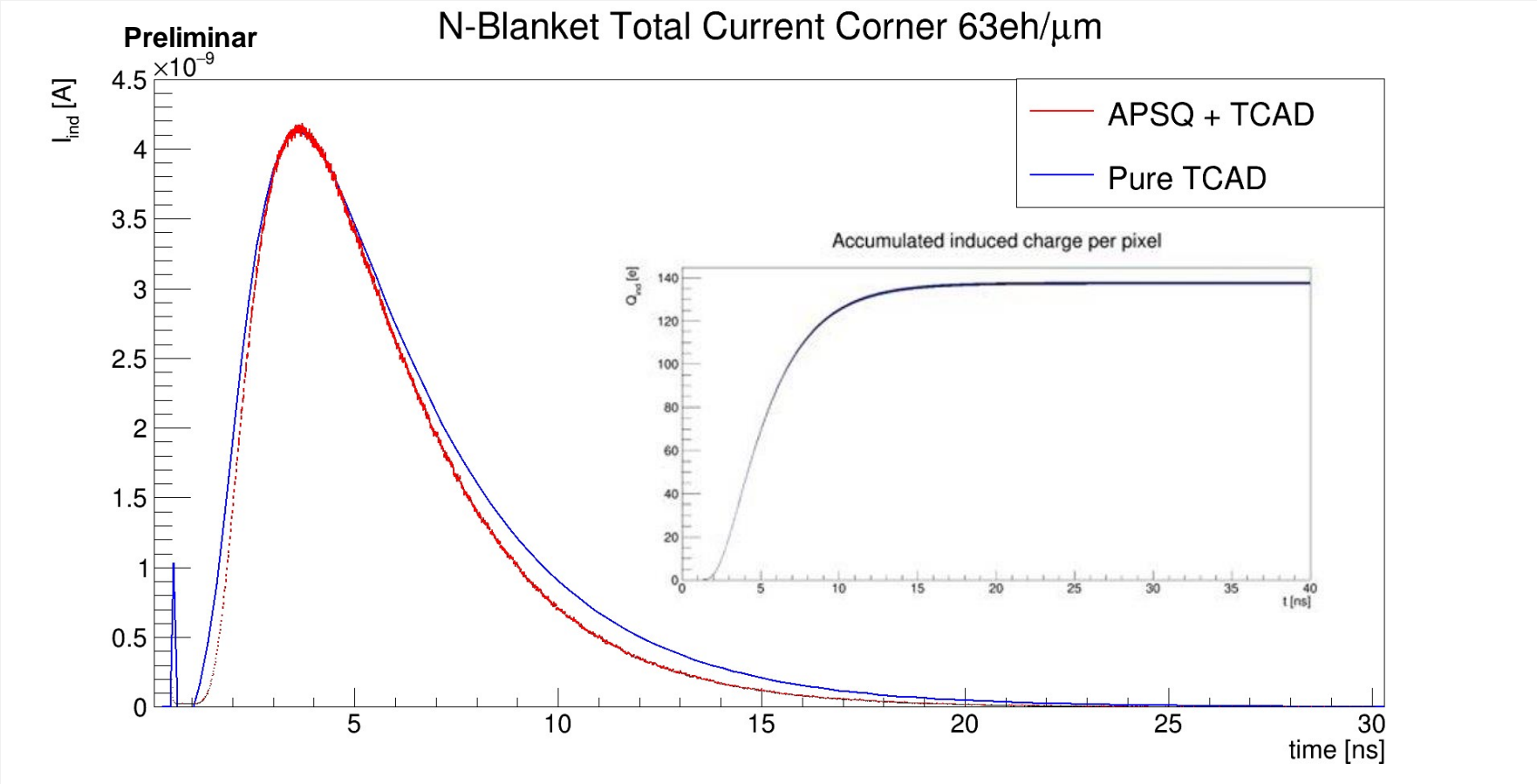


We can proceed by shooting MIP particles and thus take into account **Landau fluctuations**, **secondary particle production**, **Photoabsorbtion Ionization...**

- **Sensor and Layout Scan**
- **Timing Performance**

# Validation – Corner Injection

## Average Pulse Comparison



**N-Blanket  
Pulse duration ~ 25ns**

**Pure TCAD - 1 pulse  
APSQ + TCAD – Average 10000 pulses**